

8-BIT MICROCOMPUTER UNIT

HARDWARE FEATURES

- 32 TTL/CMOS COMPATIBLE I/O LINES
- 24 BIDIRECTIONAL (8 lines are LED compatible)
- 8 INPUT-ONLY
- 3776 BYTES OF USER ROM
- 112 BYTES OF RAM
- SELF-CHECK MODE
- ZERO-CROSSING DETECT/INTERRUPT
- INTERNAL 8-BIT TIMER WITH 7-BIT SOFTWARE PROGRAMMABLE PRESCALER AND CLOCK SOURCE
- 5V SINGLE SUPPLY

SOFTWARE FEATURES

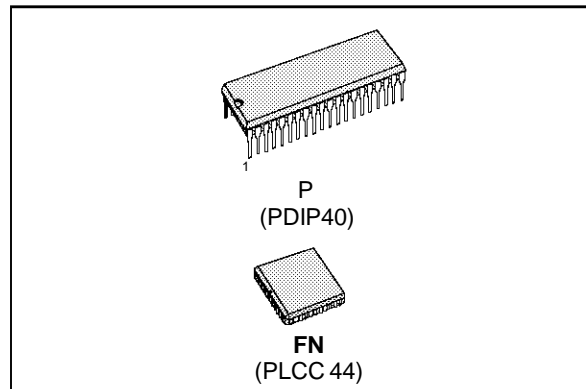
- 10 POWERFUL ADDRESSING MODES
- BYTE EFFICIENT INSTRUCTION SET WITH TRUE BIT MANIPULATION, BIT TEST, AND BRANCH INSTRUCTIONS
- SINGLE INSTRUCTION MEMORY EXAMINE/CHANGE
- POWERFUL INDEXED ADDRESSING FOR TABLES
- FULL SET OF CONDITIONAL BRANCHES
- MEMORY USABLE AS REGISTER/FLAGS
- COMPLETE DEVELOPMENT SYSTEM SUPPORT ON INICE

USER SELECTABLE OPTIONS

- 8 BIDIRECTIONAL I/O LINES WITH TTL OR TTL/CMOS INTERFACE OPTION
- 8 BIDIRECTIONAL I/O LINES WITH TTL OR OPEN-DRAIN INTERFACE OPTION
- CRYSTAL OR LOW-COST RESISTOR OSCILLATOR OPTION
- LOW VOLTAGE INHIBIT OPTION
- VECTORED INTERRUPTS : TIMER, SOFTWARE, AND EXTERNAL
- USER CALLABLE SELF-CHECK SUBROUTINES

DESCRIPTION

The EF6805U3 Microcomputer Unit (MCU) is a member of the 6805 Family of low-cost single-chip Microcomputers. The 8-bit microcomputer contains a CPU, on-chip CLOCK, ROM, RAM, I/O, and TIMER. It is designed for the user who needs an economical microcomputer with the proven capabilities of the 6800-based instruction set. A comparison of the key features of several members of the 6805 Family of Microcomputers is shown at the end of this data sheet. The following are some of the hardware and software highlights of the EF6805U3 MCU.



PIN CONNECTIONS

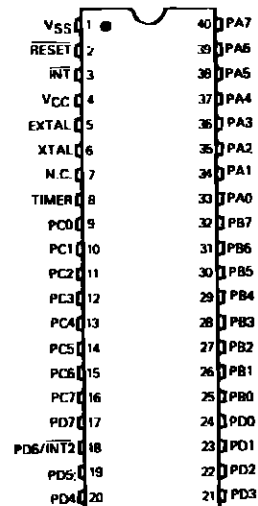
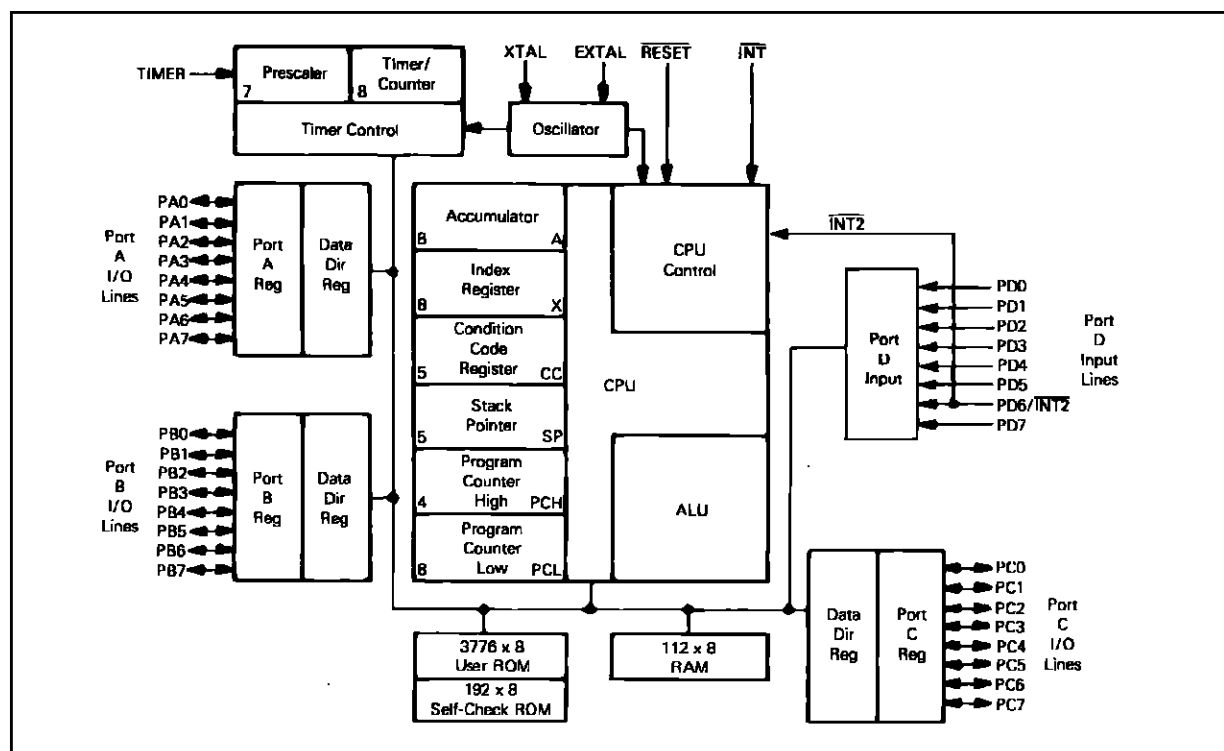


Figure 1 : EF6805U3 HMOS Microcomputer Block Diagram.



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Supply Voltage	- 0.3 to + 7.0	V
V _{in}	Input Voltage (except TIMER in self-check mode and open-drain inputs)	- 0.3 to + 7.0	V
V _{in}	Input Voltage (open-drain pins, TIMER pin in self-check mode)	- 0.3 to + 15.0	V
T _A	Operating Temperature Range (T _L to T _H)	0 to + 70 V Suffix - 40 to + 85 T Suffix - 40 to + 105	°C
T _{stg}	Storage Temperature Range	- 55 to + 150	°C
T _j	Junction Temperature		°C
	Plastic Package	150	
	PLCC	150	

This device contains circuitry to protect the inputs against damage due to high static voltages or electrical fields, however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. For proper operation it is recommended that V_{in} and V_{out} be constrained to the range V_{SS} (V_{in} or V_{out}) - V_{CC}. Reliability of operation is enhanced if unused inputs except EXTAL are tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{CC}).

THERMAL DATA

θ _{JA}	Thermal Resistance	Plastic PLCC	Value	Unit
			50	°C/W
			80	

POWER CONSIDERATIONS

The average chip-junction temperature, T_J , in C can be obtained from :

$$T_J = T_A + (P_D \cdot J_A) \quad (1)$$

Where :

T_A = Ambient Temperature, C

J_A = Package Thermal Resistance, Junction-to-Ambient, C/W

$P_D = P_{INT} + P_{PORT}$

$P_{INT} = I_{CC} \times V_{CC}$, Watts - Chip Internal Power

P_{PORT} = Port Power Dissipation, Watts - User Determined

For most applications P_{PORT} P_{INT} and can be neglected. P_{PORT} may become significant if the device

is configured to drive Darlington bases or sink LED loads.

An approximate relationship between P_D and T_J (if P_{PORT} is neglected) is :

$$P_D = K + (T_J + 273C) \quad (2)$$

Solving equations 1 and 2 for K gives :

$$K = P_D \cdot (T_A + 273C) + J_A \cdot P_D^2 \quad (3)$$

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring P_D (at equilibrium) for a known T_A . Using this value of K the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

ELECTRICAL CHARACTERISTICS ($V_{CC} = +5.25V_{dc} \pm 0.5V_{dc}$, $V_{SS} = 0V_{dc}$, $T_A = T_L$ to T_H unless otherwise noted)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{IH}	Input High Voltage				V
	RESET ($4.75 \leq V_{CC} \leq 5.75$)	4.0		V_{CC}	
	($V_{CC} < 4.75$)	$V_{CC} - 0.5$		V_{CC}	
	INT ($4.75 \leq V_{CC} \leq 5.75$)	4.0	•	V_{CC}	
	($V_{CC} < 4.75$)	$V_{CC} - 0.5$	•	V_{CC}	
	All Other (except timer)	2.0		V_{CC}	
V_{IH}	Input High Voltage Timer				V
	Timer Mode	2.0		$V_{CC} + 1.0$	
	Self-check Mode	9.0	10.0	15.0	
V_{IL}	Input Low Voltage				V
	RESET	V_{SS}		0.8	
	INT	V_{SS}	•	1.5	
	All Other	V_{SS}		0.8	
V_{IRES+} V_{IRES-}	RESET Hystereris Voltages (see figures 10, 11 and 12)				V
	"Out of Reset"	2.1		4.0	
	"Into Reset"	0.8		2.0	
V_{INT}	INT Zero Crossing Input Voltage, Through a Capacitor	2		4	$V_{ac p-p}$
P_D	Power Dissipation - (no port loading, $V_{CC} = 5.75V$)				mW
		$T_A = 0^\circ C$	520	740	
	$T_A = -40^\circ C$	580	800		
C_{in}	Input Capacitance				pF
	EXTAL		25		
	All Other		10		
V_{LVR}	Low Voltage Recover			4.75	V
V_{LVI}	Low Voltage Inhibit	2.75	3.75	4.70	V
I_{in}	Input Current				μA
	TIMER ($V_{in} = 0.4V$)			20	
	INT ($V_{in} = 2.4V$ to V_{CC})		20	50	
	EXTAL ($V_{in} = 2.4V$ to V_{CC} - crystal option)			10	
	($V_{in} = 0.4V$ - crystal option)			- 1600	
RESET ($V_{in} = 0.8V$) - External Capacitor Charging Current	- 40.0			- 40	

* Due to internal biasing this input (when unused) floats to approximately 2.2V.

SWITCHING CHARACTERISTICS
 $(V_{CC} = +5.25V_{dc} \pm 0.5V_{dc}, V_{SS} = 0V_{dc}, T_A = T_L \text{ to } T_H \text{ unless otherwise noted})$

Symbol	Parameter	Min.	Typ.	Max.	Unit
f_{osc}	Oscillator Frequency	0.4		4.2	MHz
t_{cyc}	Cycle Time ($4/f_{osc}$)	0.95		10	μs
t_{WL}, t_{WH}	\overline{INT} , $\overline{INT2}$, and \overline{TIMER} Pulse Width (see interrupt section)	$t_{cyc} + 250$			ns
t_{RWL}	\overline{RESET} Pulse Width	$t_{cyc} + 250$			ns
f_{INT}	\overline{INT} Zero-crossing Detection Input Frequency	0.03		1	kHz
	External Clock Input Duty Cycle (EXTAL)	40	50	60	%
	Crystal Oscillator Start-up Time*			100	ms

PORT ELECTRICAL CHARACTERISTICS
 $(V_{CC} = +5.25V_{dc} \pm 0.5V_{dc}, V_{SS} = 0V_{dc}, T_A = T_L \text{ to } T_H \text{ unless otherwise noted})$
PORT A WITH CMOS DRIVE ENABLED

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{OL}	Output Low Voltage ($I_{Load} = 1.6mA$)			0.4	V
V_{OH}	Output High Voltage $I_{Load} = -100\mu A$ $I_{Load} = -10\mu A$	2.4 $V_{CC} - 1.0$			V
V_{IH}	Input High Voltage ($I_{Load} = -300\mu A \text{ max.}$)	2.0		V_{CC}	V
V_{IL}	Input Low Voltage ($I_{Load} = -500\mu A \text{ max.}$)	V_{SS}		0.8	V
I_{IH}	High Z State Input Current ($V_{in} = 2.0V \text{ to } V_{CC}$)			-300	μA
I_{IL}	High Z State Input Current ($V_{in} = 0.4V$)			-500	μA

PORT B

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{OL}	Output Low Voltage $I_{Load} = 3.2mA$ $I_{Load} = 10mA \text{ (sink)}$			0.4 1.0	V
V_{OH}	Output High Voltage $I_{Load} = -200\mu A$	2.4			V
I_{OH}	Darlington Current Drive (source) $V_O = 1.5V$	-1.0		-10	mA
V_{IH}	Input High Voltage	2.0		V_{CC}	V
V_{IL}	Input Low Voltage	V_{SS}		0.8	V
I_{TSI}	High Z State Input Current		< 2	10	μA

PORT C AND PORT A WITH CMOS DRIVE DISABLED

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{OL}	Output Low Voltage $I_{Load} = 1.6mA$			0.4	V
V_{OH}	Output High Voltage $I_{Load} = -100\mu A$	2.4			V
V_{IH}	Input High Voltage	2.0		V_{CC}	V
V_{IL}	Input Low Voltage	V_{SS}		0.8	V
I_{TSI}	High Z State Input Current		< 2	10	μs

Figure 2 : TTL Equivalent Test Load (port B).

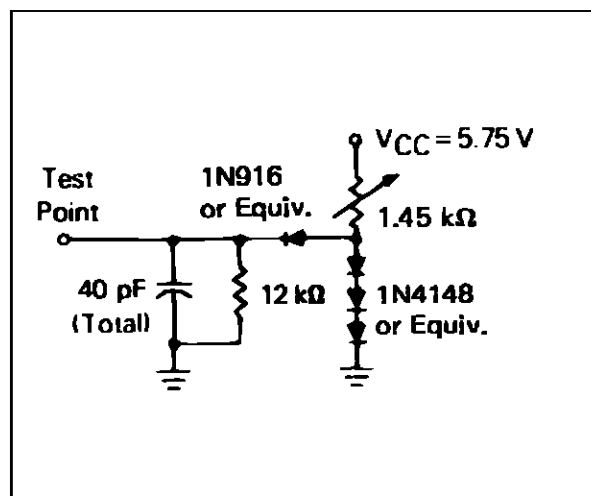


Figure 3 : CMOS Equivalent Test Load (port A).

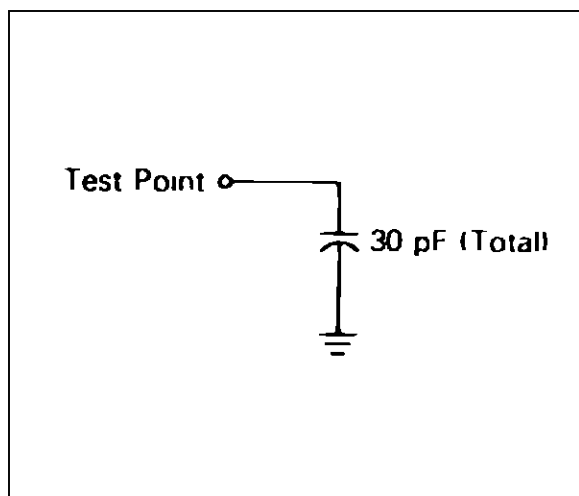


Figure 4 : TTL Equivalent Test Load (port A and C).

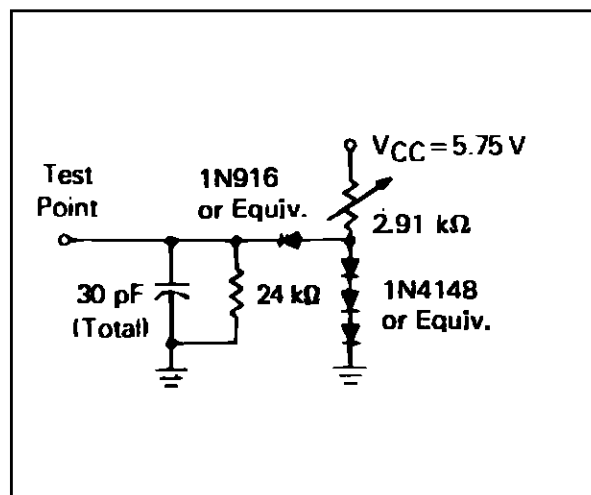
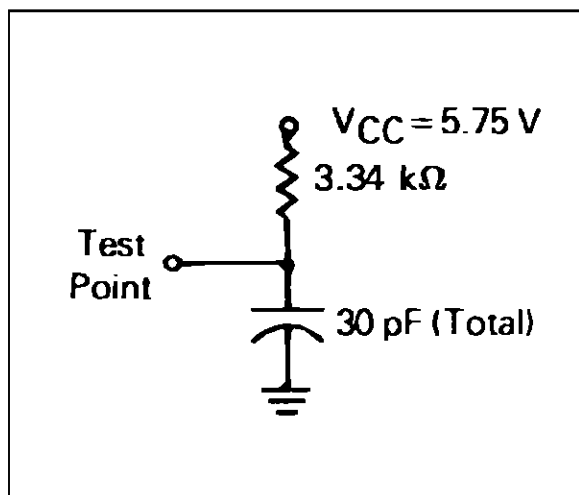


Figure 5 : Open-drain Equivalent Test Load (port C).



SIGNAL DESCRIPTION

The input and output signals for the MCU, shown in figure 1, are described in the following paragraphs.

V_{CC} AND V_{SS} - Power is supplied to the MCU using these two pins. V_{CC} is power and V_{SS} is the ground connection.

INT - This pin provides the capability for asynchronously applying an external interrupt to the MCU. Refer to Interrupts Section for additional information.

XTAL AND EXTAL - These pins provide control input for the on-chip clock oscillator circuit. A crystal, a resistor, or an external signal, depending on user selectable manufacturing mask option, can be connected to these pins to provide a system clock with various degrees of stability/cost tradeoffs. Lead

length and stray capacitance on these two pins should be minimized. Refer to Internal Clock Generator Options Section for recommendations about these inputs.

NOTE : Pin 7 in DIL package/pin 8 in PLCC package is connected to internal protection.

TIMER - The pin allows an external input to be used to control the internal timer circuitry and also to initiate the self test program. Refer to Timer Section for additional information about the timer circuitry.

RESET - This pin allows resetting of the MCU at times other than the automatic resetting capability already in the MCU. The MCU can be reset by pulling RESET low. Refer to Resets Section for additional information.

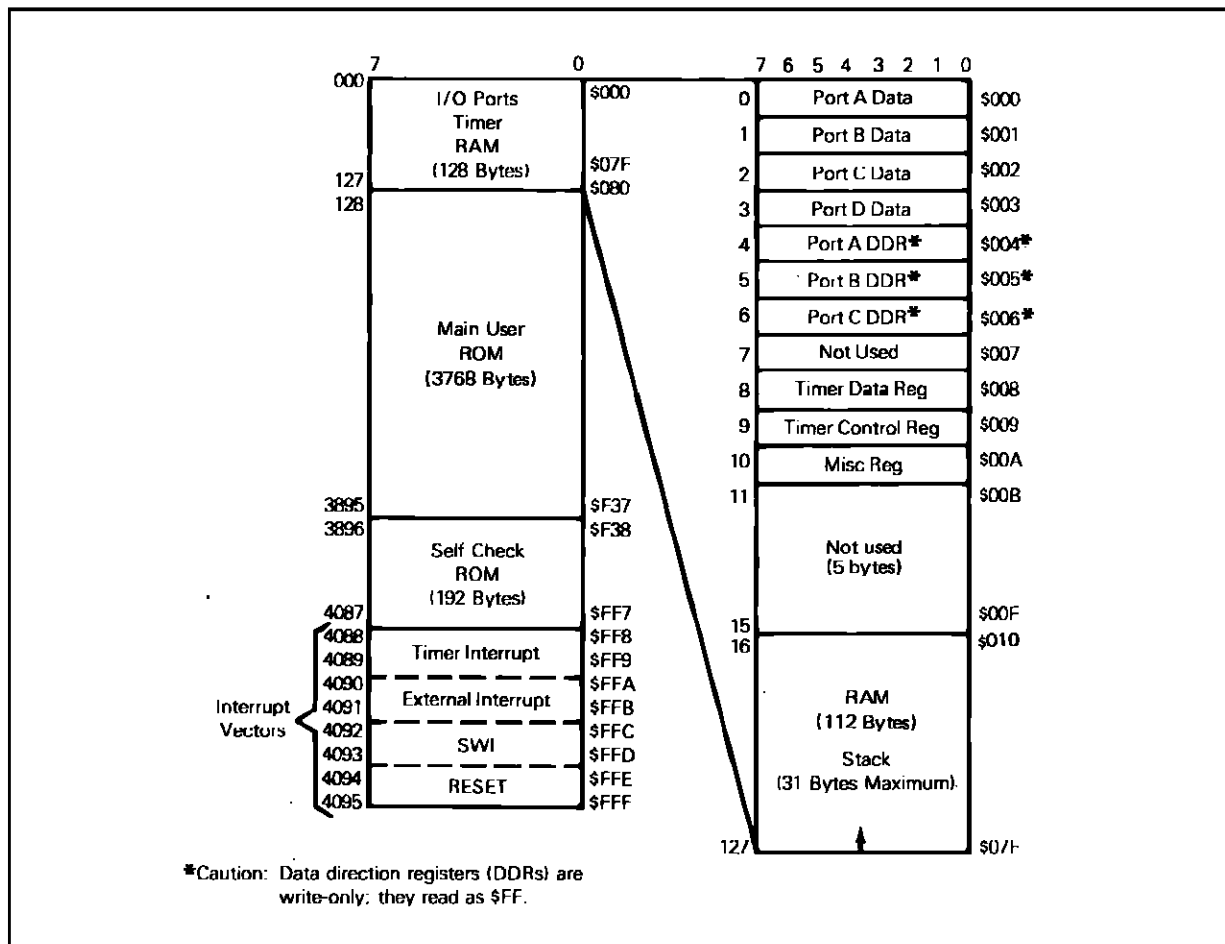
INPUT/OUTPUT LINES (PA0-PA7, PB0-PB7, PC0-PC7, PD0-PD7) - These 32 lines are arranged into four 8-bit ports (A, B, C, and D). Ports A, B, and C are programmable as either inputs or outputs under software control of the data direction registers (DDRs). Port D is for digital input only and bit 6 may be used for a second interrupt INT2. Refer to Input/Output Section and Interrupts Section for additional information.

MEMORY - The MCU is capable of addressing 4096 bytes of memory and I/O registers with its program counter. The EF6805U3 MCU has implemented 4090 of these bytes. This consists of : 3776 user ROM bytes, 192 self-check ROM bytes, 112 user RAM bytes, 7 port I/O bytes, 2 timer registers, and a miscellaneous register ; see figure 6 for the Address map. The user ROM has been split into two areas. The main user ROM area is from \$080 to \$F37. The last 8 user ROM locations at the bottom of memory are for the interrupt vectors.

The MCU reserves the first-16 memory locations for I/O features, of which 10 have been implemented. These locations are used for the ports, the port DDRs, the timer and the INT2 miscellaneous register, and the 112 RAM bytes, 31 bytes are shared with the stack area. The stack must be used with care when data shares the stack area.

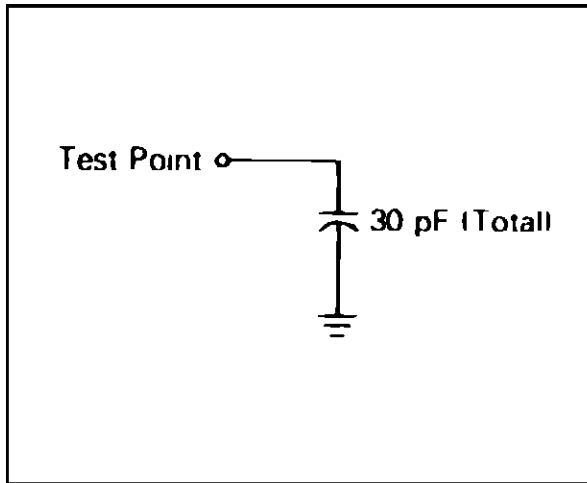
The shared stack area is used during the processing of an interrupt or subroutine calls to save the contents of the CPU state. The register contents are pushed onto the stack in the order shown in figure 7. Since the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first, then the high order four bits (PCH) are stacked. This ensures that the program counter is loaded correctly during pulls from the stack since the stack pointer increments when it pulls data from the stack. A subroutine call results in only the program counter (PCL, PCH) contents being pushed onto the stack ; the remaining CPU registers are not pushed.

Figure 6 : EF6805U3 MCU Address Map.



* Caution : Data direction registers (DDRs) are write only, they read as \$FF.

Figure 6 : Interrupt Stacking Order.



CENTRAL PROCESSING UNIT

The CPU of the EF6805 Family is implemented independently from the I/O or memory configuration.

Consequently, it can be treated as an independent central processor communicating with I/O and memory via internal address, data, and control buses.

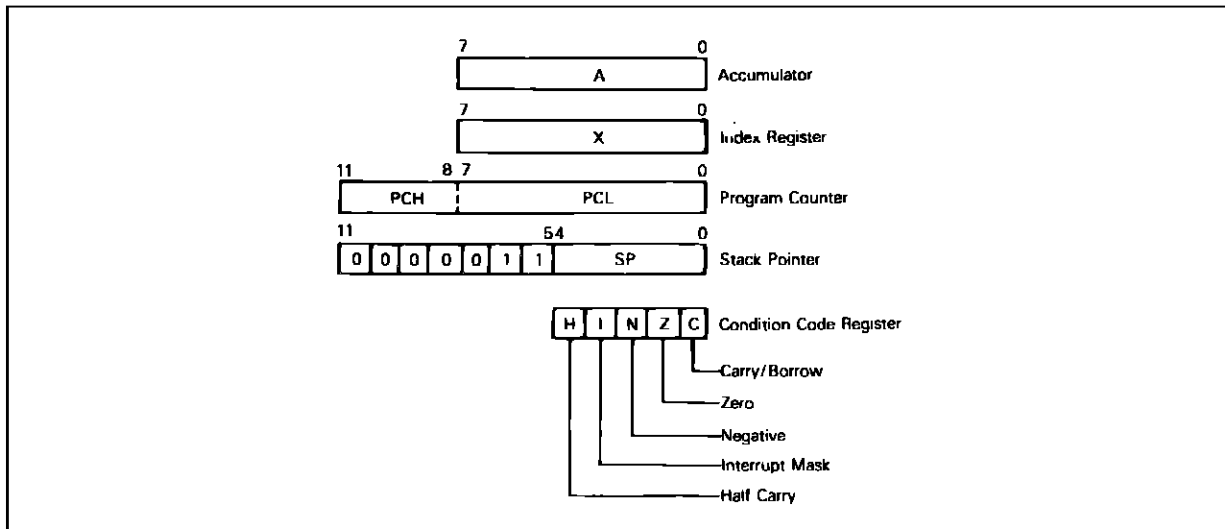
REGISTERS

The 6805 Family CPU has five registers available to the programmer. They are shown in figure 8 and are explained in the following paragraphs.

ACCUMULATOR (A) - The accumulator is a general purpose 8-bit register used to hold operands and results of arithmetic calculations or data manipulations.

INDEX REGISTER (X) - The index register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit value that may be added to an instruction value to create an effective address. The index register can also be used for data manipulations using the read-modify-write instructions. The Index Register may also be used as a temporary storage area.

Figure 8 : Programming Model.



PROGRAM COUNTER (PC) - The Program Counter is a 12 bit register that contains the address of the next instruction to be executed.

STACK POINTER (SP) - The stack pointer is a 12-bit register that contains the address of the next free location on the stack. During an MCU reset or the reset stack pointer (RSP) instruction, the stack pointer is set to location \$07F. The stack pointer is then decremented as data is pushed onto the stack and incremented as data is then pulled from the stack. The seven most significant bits of the stack pointer are permanently set to 000011. Subroutines and

interrupts may be nested down to location \$061 (31 bytes maximum) which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed).

CONDITION CODE REGISTER (CC) - The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each bit is explained in the following paragraphs.

Half Carry (H) - Set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4.

Interrupt (I) - When this bit is set, the timer and external interrupts (INT and INT2) are masked (disabled). If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared.

Negative (N) - When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logical "1").

Zero (Z) - When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was zero.

Carry/Borrow (C) - When set, this bit indicates that a carry or borrow out of the Arithmetic Logic Unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates.

TIMER

The timer circuitry for the EF6805U3 is shown in figure 10. The timer contains a single 8-bit software programmable counter with a 7-bit software selectable prescaler. The counter may be preset under program control and decrements toward zero. When the counter decrements to zero, the timer interrupt request bit, i.e., bit 7 of the timer control register (TCR), is set. Then if the timer interrupt is not masked, i.e., bit 6 of the TCR and the I bit in the condition code register are both cleared, the processor receives an interrupt. After completion of the current instruction, the processor proceeds to store the appropriate registers on the stack, and then fetches the timer interrupt vector from locations \$FF8 and \$FF9 in order to begin servicing the interrupt.

The counter continues to count after it reaches zero, allowing the software to determine the number of internal or external input clocks since the timer interrupt request bit was set. The counter may be read at any time by the processor without disturbing the count. The contents of the counter become stable prior to the read portion of a cycle and do not change during the read. The timer interrupt request bit remains set until cleared by the software. If a write occurs before the timer interrupt is serviced, the interrupt is lost. TCR7 may also be used as a scanned status bit in a non-interrupt mode of operation (TCR6 = 1).

The prescaler is a 7-bit divider which is used to extend the maximum length of the timer. Bit 0, bit 1, and bit 2 of the TCR are programmed to choose the appropriate prescaler output which is used as the counter input. The processor cannot write to or

read from the prescaler ; however, its contents are cleared to all zeros by the write operation into TCR when bit 3 of the written data equals one, which allows for truncation-free counting.

The timer input can be configured for three different operating modes, plus a disable mode, depending on the value written to the TCR4 and TCR5 control bits. For further information see figure 9.

Timer Input Mode 1 - If TCR5 and TCR4 are both programmed to a zero, the input to the timer is from an internal clock and the external TIMER input is disabled. The internal clock mode can be used for periodic interrupt generation, as well as a reference frequency and event measurement. The internal clock is the instruction cycle clock.

Timer Input Mode 2 - With TCR5 = 0 and TCR4 = 1, the internal clock and the TIMER input pin are ANDed to form the timer input signal. This mode can be used to measure external pulse widths. The external timer input pulse simply turns on the internal clock for the duration of the pulse widths.

Timer Input Mode 3 - If TCR5 = 1 and TCR4 = 0, then all inputs to the timer are disabled.

Timer Input Mode 4 - If TCR5 = 1 and TCR4 = 1, the internal clock input to the timer is disabled and the TIMER input pin becomes the input to the timer. The external TIMER pin can, in this mode, be used to count external events as well as external frequencies for generating periodic interrupts.

TCR7 - Timer Interrupt Request Bit :

7	6	5	4	3	2	1	0
TCR7	TCR6	TCR5	TCR4	TCR3	TCR2	TCR1	TCR0

* Write only (read as zero).

- 1 - Set when TDR goes to zero, or under program control
- 0 - Cleared on external Reset, Power-On-Reset, or under Program Control.

TCR6 - Timer Interrupt Mask Bit :

- 1 - Timer Interrupt masked (disabled) Set on external Reset, Power-On-Reset, or under Program Control
- 0 - Cleared under Program Control.

TCR5 - External or Internal Clock Source Bit :

- 1 - External Clock Source. Set on external Reset, Power-On-Reset, or under Program Control
- 0 - Cleared under Program Control.

TCR4 - External Enable Bit :

- 1 - Enable external TIMER pin. Set on external Reset, Power-On-Reset, or under Program Control

Control.
 0 - Cleared under Program Control.
 TCR3 - Timer prescaler reset bit : A read of TCR3

TCR2 , TCR1, and TCR0 - Prescaler address bits :
 1 - All set on external Reset, Power-On-Reset or under Program Control.
 0 - Cleared under Program Control.

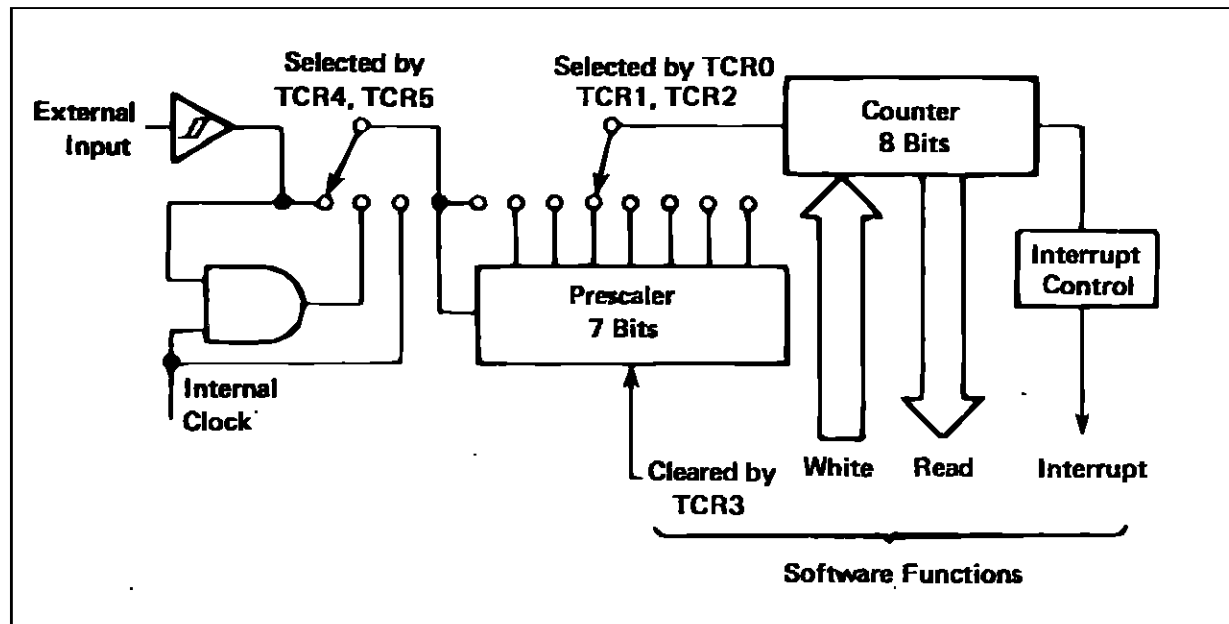
TCR5	TCR4	Result
0	0	Internal Clock to Timer
0	1	AND of Internal Clock and TIMER Pin to Timer
1	0	Input to timer disabled.
1	1	TIMER Pin to Timer

always indicates a zero.
 1 - Set on external Reset, Power-On-Reset or under Program Control.
 0 - Cleared under Program Control

Figure 9 : Timer Control Register (TCR).

TCR2	TCR1	TCR0	Result	TCR2	TCR1	TCR0	Result
0	0	0	+ 1	1	0	0	+ 16
0	0	1	+ 2	1	0	1	+ 32
0	1	0	+ 4	1	1	0	+ 64
0	1	1	+ 8	1	1	1	+ 128

Figure 10 : Timer Block Diagram.



Notes : 1. Prescaler and 8-bit counter are clocked on the falling edge of the internal clock (AS) or external input.
 2. Counter is written to during dat strobe (DS) and counts down continuously.

SELF-CHECK - The self-check capability of the EF6805U3 MCU provides an internal check to determine if the part is functional. Connect the MCU as shown in figure 11 and monitor the output of Port C bit 3 for an oscillation of approximately 7Hz. A 10-volt level (through a 10k resistor) on the timer input, pin 8 and pressing then releasing the RESET button, energizes the ROM-based self-check feature. The self-check program exercises the RAM, ROM, TIMER, interrupts, and I/O ports.

Several of the self-check subroutines can be called by a user program with a JSR or BSR instruction. They are the RAM, ROM. The timer routine may also be called if the timer input is the internal 2 clock.

To call those subroutines in customer application, please contact your local SGS-THOMSON Microelectronics sales office in order to obtain the complete description of the self-check program and the entrance/exit conditions.

RAM SELF-CHECK SUBROUTINE - The RAM self-check is called at location \$F84 and returns with the Z bit clear if any error is detected ; otherwise the Z bit is set. The RAM test causes each byte to count from 0 up to 0 again with a check after each count.

The RAM test must be called with the stack pointer at \$07F and A = 0. When run, the test checks every RAM cell except for \$07F and \$07E which are assumed to contain the return address.

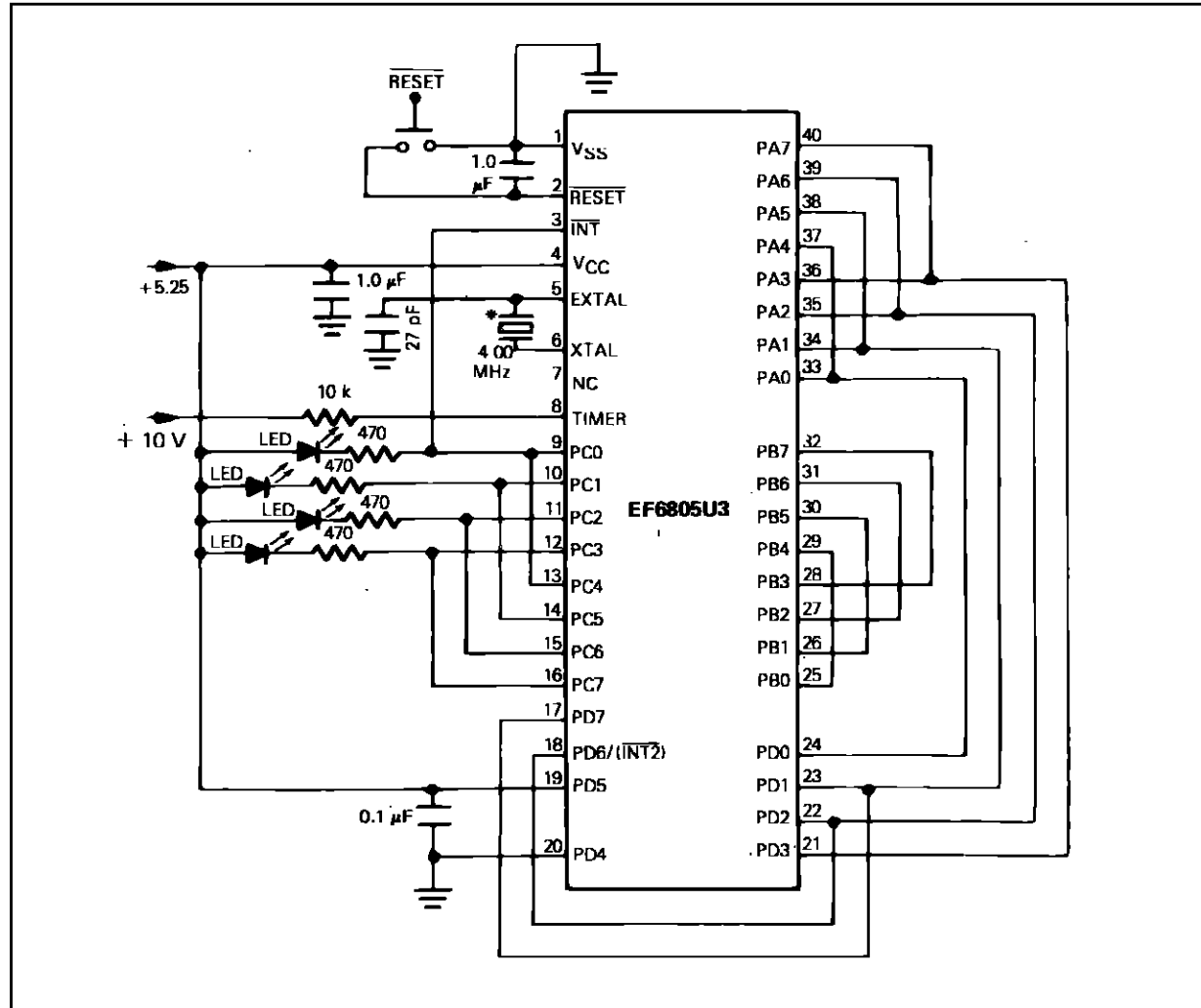
The A and X registers and all RAM locations except \$07F and \$07E are modified.

ROM CHECKSUM SUBROUTINE - The ROM self-check is called at location \$F95. The A register should be cleared before calling the routine. If any error is detected, it returns with the Z bit cleared ;

otherwise Z = 1, X = 0 on return, and A is zero if the test passes. RAM location \$040 to \$043 is overwritten. The checksum is the complement of the execution OR of the contents of the user ROM.

* This connection depends on clock oscillator user selectable mask option. Use jumper if the RC mask option is selected.

Figure 11 : Self-check Connections.



LED MEANINGS

PC0	PC1	PC2	PC3	Remarks (1 : LED ON ; 0 : LED OFF)
1	0	1	0	Bad I/O
0	0	1	0	Bad Timer
1	1	0	0	Bad RAM
0	1	0	0	Bad ROM
0	0	0	0	Bad Interrupts or Request Flag
All Flashing				Good Device

TIMER SELF-CHECK SUBROUTINE - The timer self-check is called at location \$F6D and returns with the Z bit cleared if any error was found ; otherwise Z = 1.

In order to work correctly as a user subroutine, the internal 2 clock must be the clocking source and interrupts must be disabled. Also, on exit, the clock is running and the interrupt mask is not set so the caller must protect from interrupts if necessary.

The A and X register contents are lost. This routine sets the prescaler for divide-by-128 and the timer data register is cleared. The X register is configured to count down the same as the timer data register. The two registers are then compared every 128 cycles until they both count down to zero. Any mismatch during the count down is considered as an error. The A and X registers are cleared on exit from the routine.

RESET

The MCU can be reset three ways : by initial powerup, by the external reset input (RESET) and by an optional internal low-voltage detect circuit. The RESET input consists mainly of a Schmitt trigger which senses the RESET line logic level. A typical reset Schmitt trigger hysteresis curve is shown in figure 12. The Schmitt trigger provides an internal reset voltage if it senses a logical zero on the RESET pin. Power-On Reset (POR) - An internal reset is generated upon powerup that allows the internal clock generator to stabilize. A delay of t_{RHL} milliseconds is required before allowing the RESET input to go high. Refer to the power and reset timing diagram of figure 13. Connecting a capacitor to the RESET input (as illustrated in figure 14) typically provides sufficient delay. During powerup, the Schmitt trigger switches on (removes reset) when RESET rises to V_{IRES+} .

Figure 12 : Typical Reset Schmitt Trigger Hysteresis.

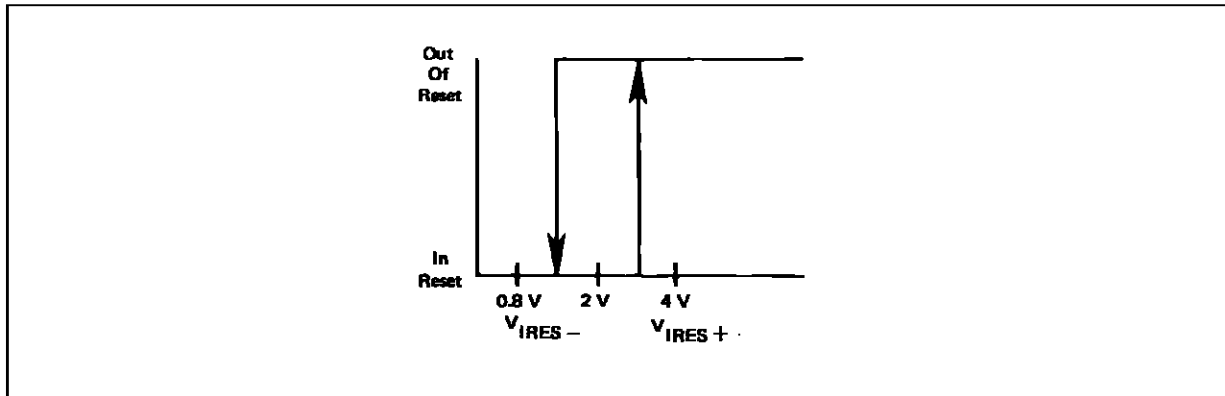


Figure 13 : Power and Reset Timing.

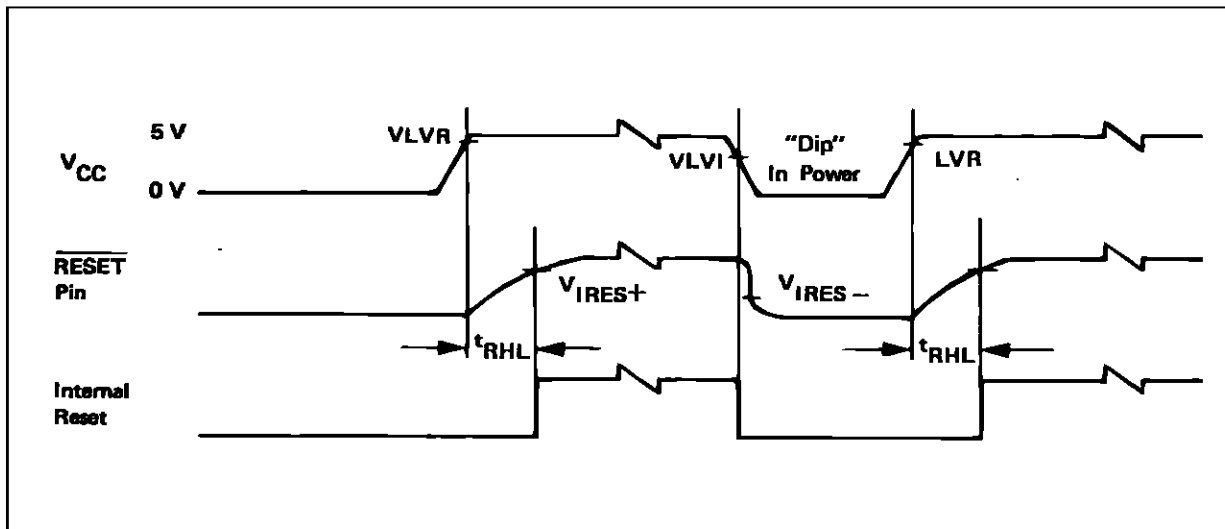
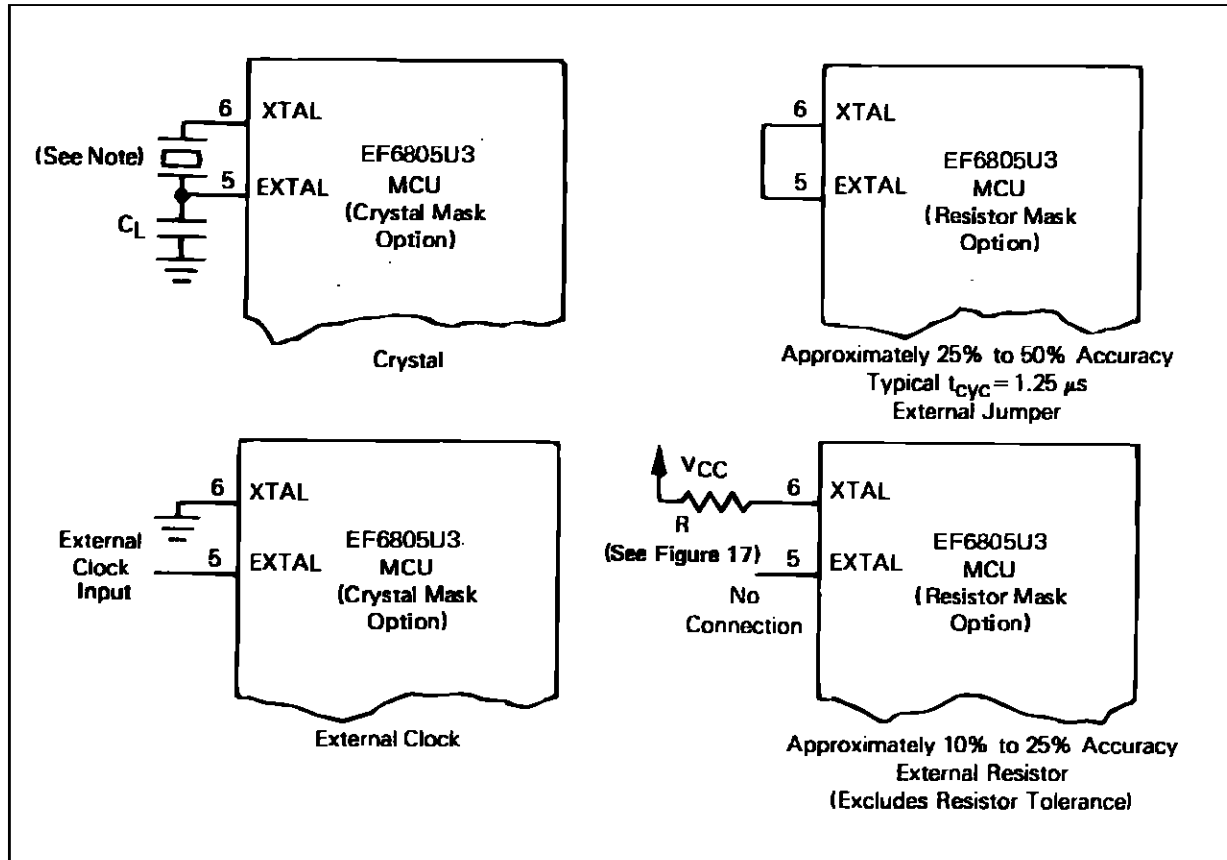


Figure 15 : Clock Generator Options.



Note : The recommended C_L value with a 4.0 MHz crystal is 27pF, maximum, including system distributed capacitance. There is an internal capacitance of approximately 25pF on the XTAL pin. For crystal frequencies other than 4MHz, the total capacitance on each pin should be scaled as the inverse of the frequency ratio. For example, with a 2MHz crystal, use approximately 50pF on EXTAL and approximately 25pF on XTAL. The exact value depends on the Motional-Arm parameters of the crystal used.

Figure 16 : Crystal Motional ARM parameters and Suggested PC Board layout.

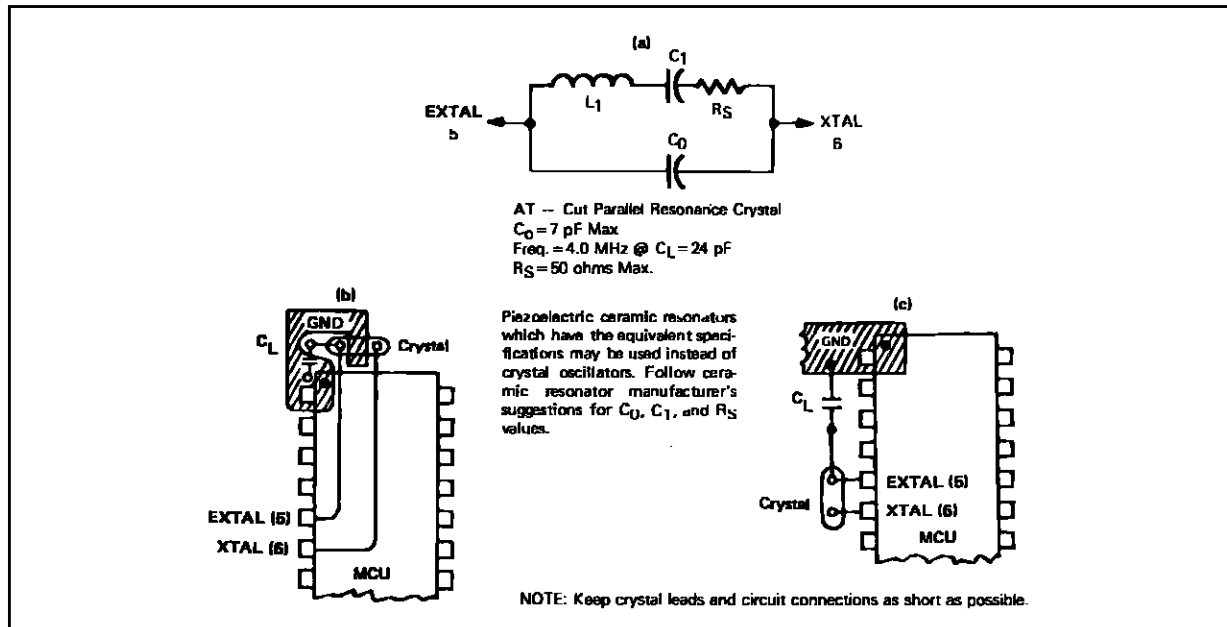
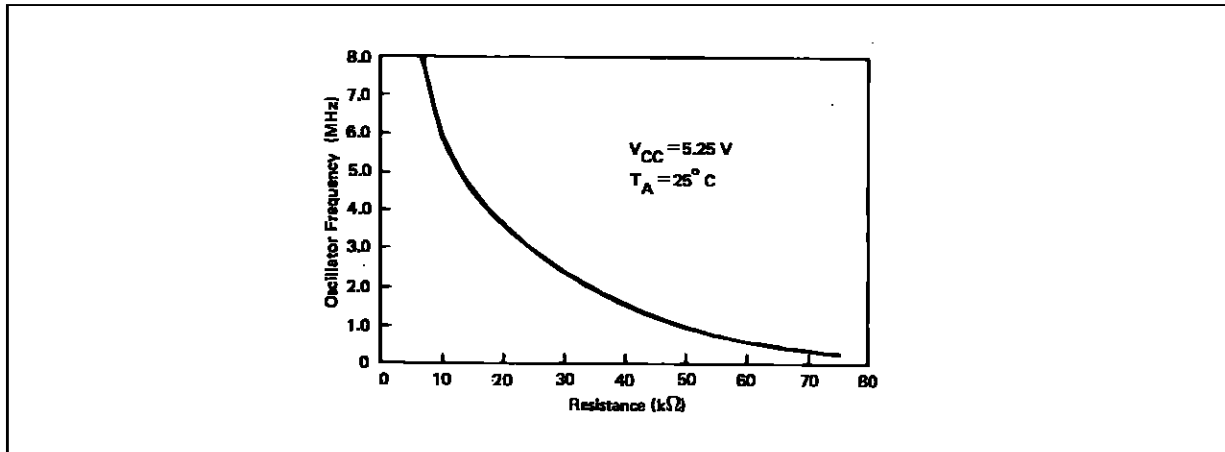


Figure 17 : Typical Frequency Selection for resistor (oscillator option).



INTERRUPTS

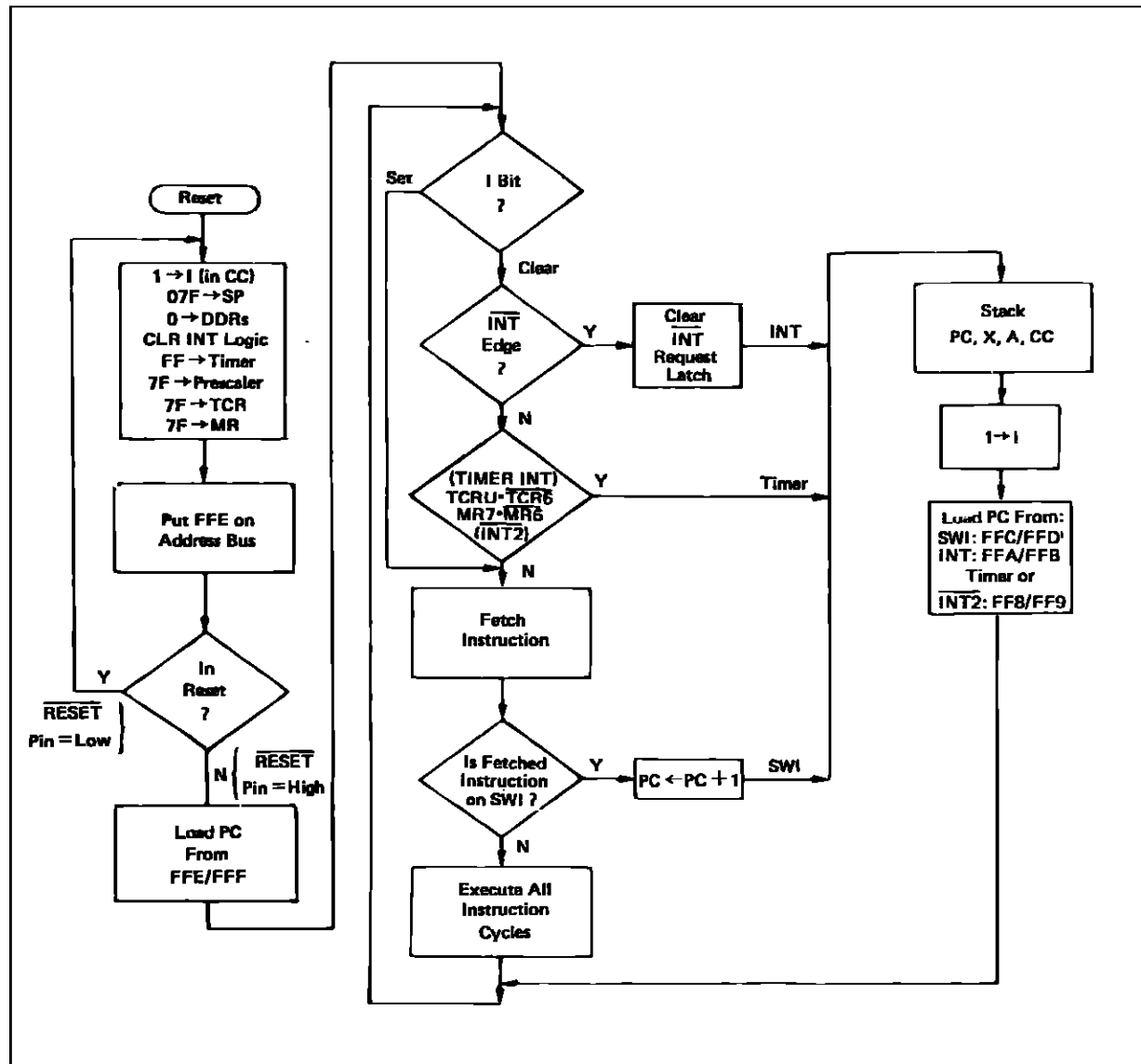
The microcomputers can be interrupted four different ways : through the external interrupt (INT) input pin, the internal timer interrupt request, the external port D bit 6 (INT2) input pin, or the software interrupt instruction (SWI). When any interrupt occurs : the current instruction (including SWI) is completed, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the condition code register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed. Stacking the CPU register, setting the I bit, and vector fetching require a total of 11 t_{cyc} periods for completion. A flowchart of the interrupt sequence is shown in figure 18. The interrupt service routine must end with a return from interrupt (RTI)

instruction which allows the MCU to resume processing of the program prior to the interrupt (by unstacking the previous CPU state). Unlike RESET, hardware interrupts do not cause the current instruction execution to be halted, but are considered pending until the current instruction execution is complete.

When the current instruction is complete, the processor checks all pending hardware interrupts and if unmasked, proceeds with interrupt processing ; otherwise the next instruction is fetched and executed. Note that masked interrupts are latched for later interrupt service.

If both an external interrupt and a timer interrupt are pending at the end of an instruction execution, the external interrupt is serviced first. The SWI is executed as any other instruction.

Figure 18 : RESET and interrupt Processing Flowchart.

**NOTE**

The timer and INT2 interrupts share the same vector address. The interrupt routine must determine the source by examining the interrupt request bits (TCR b7 and MR b7). Both TCR b7 and MR b7 can only be written to zero by software.

The external interrupt, INT and INT2, are synchronized and then latched on the falling edge of the input signal. The INT2 interrupt has an interrupt request bit (bit 7) and a mask bit (bit 6) located in the miscellaneous register (MR). The INT2 interrupt is inhibited when the mask bit is set. The INT2 is always read as a digital input on port D. The INT2 and timer interrupt requests bits, if set, cause the MCU to

process an interrupt when the condition code I bit is clear.

A sinusoidal input signal (f_{INT} maximum) can be used to generate an external interrupt for use as a zero-crossing detector. This allows applications such as servicing time-of-day routines and engaging/disengaging ac power control devices. Off-chip full wave rectification provides an interrupt at every zero crossing of the ac signal and thereby provides a 2f clock. See figure 19.

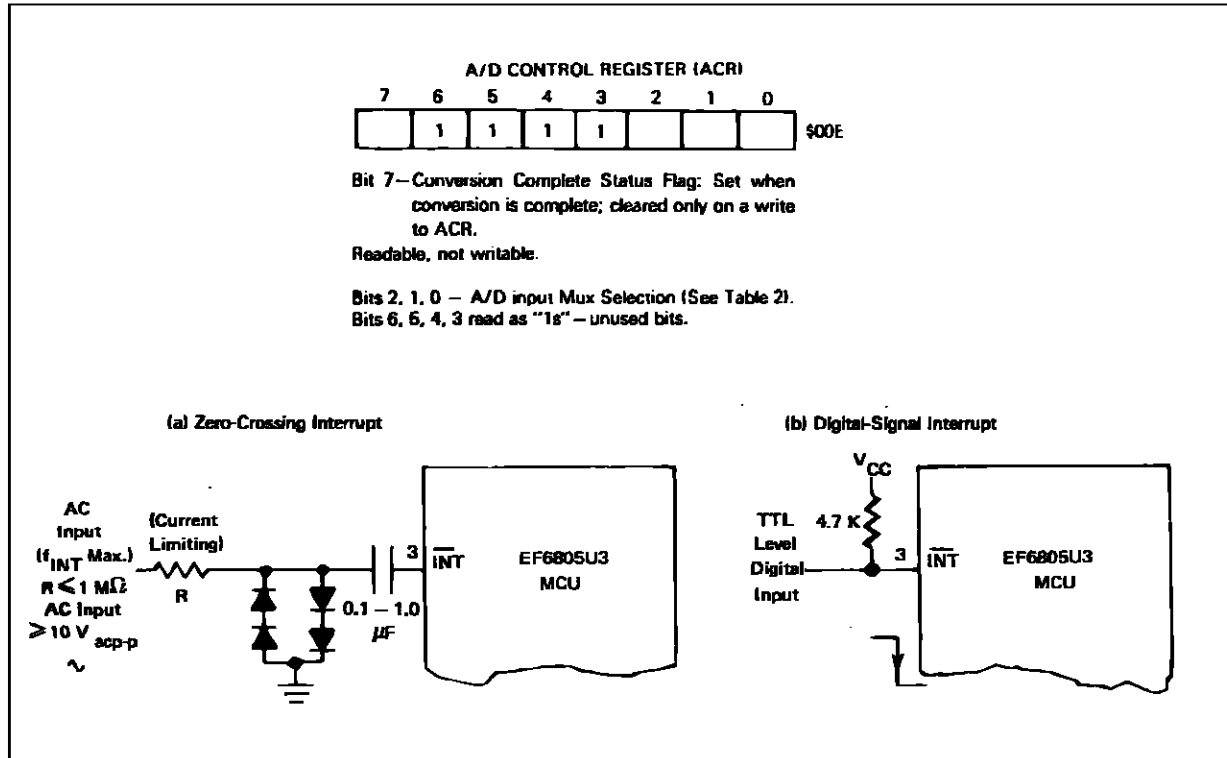
NOTE

The INT (pin 3) is internally biased at approximately 2.2V due to the internal zero-crossing detection.

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the I bit in the condition code register. SWIs are usually

used as break-points for debugging or a system calls.

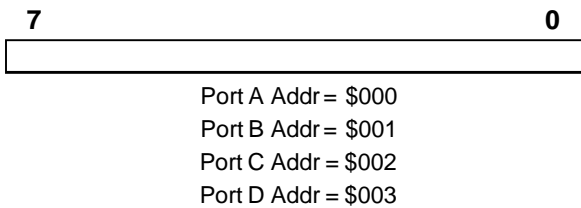
Figure 19 : Typical Interrupt Circuits.



INPUT/OUTPUT CIRCUITRY

There are 32 input/output pins. The INT pin may be polled with branch instructions to provide an additional input pin. All pins on ports A, B, and C are programmable as either inputs or outputs under software control of the corresponding data direction register (DDR). See below I/O port control registers configuration. The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic one for output or a logic zero for input. On reset all the DDRs are initialized to a logic zero state, placing the ports in the input mode. The port output registers are not initialized on reset and should be initialized by software before changing the DDRs from input to output. A read operation on a port programmed as an output will read the contents of the output latch regardless of the logic levels at the output pin, due to output loading. Refer to figure 20.

PORT DATA REGISTER



PORT DATA DIRECTION REGISTER (DDR)

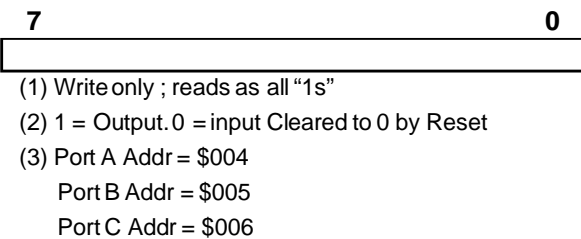
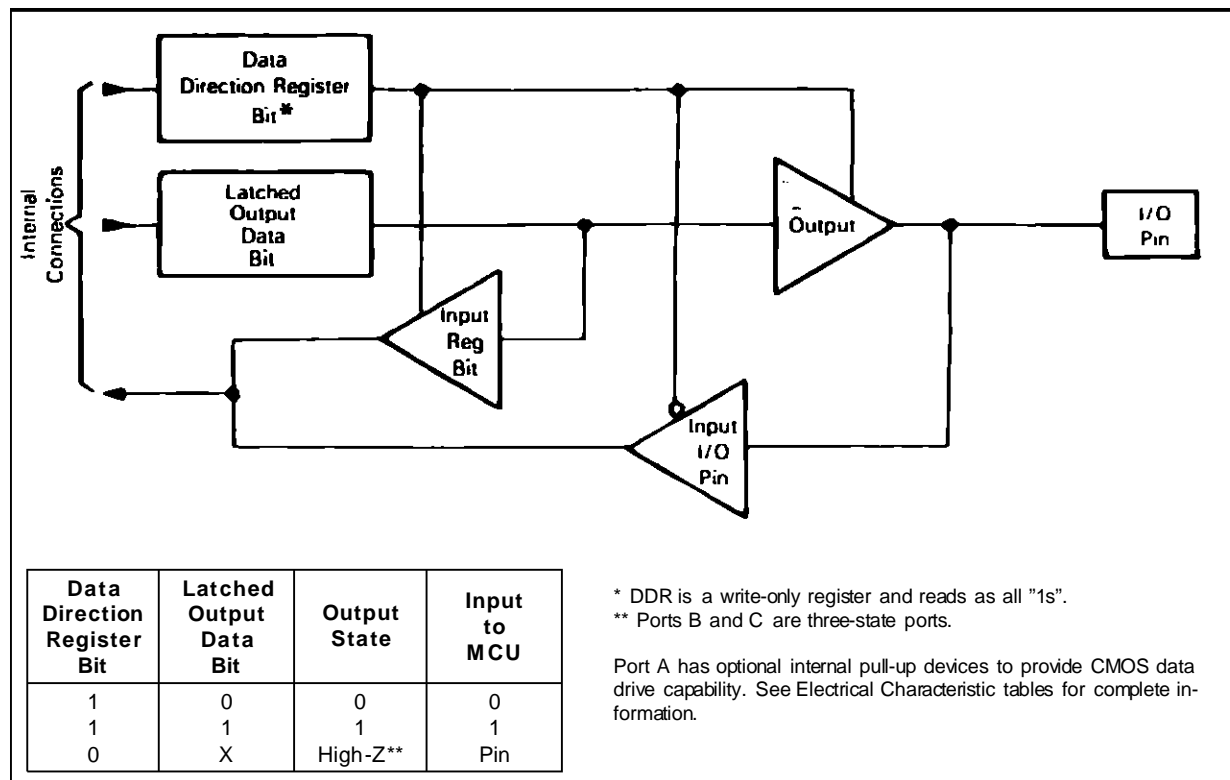


Figure 20 : Typical Port I/O Circuitry.



All input/output lines are TTL compatible as both inputs and outputs. Port A lines are CMOS compatible as outputs (mask option) while port B, C, and D lines are CMOS compatible as inputs. Port D lines are input only ; thus, there is no corresponding DDR. When programmed as outputs, port B is capable of sinking 10 milliamperes and sourcing 1 milliampere on each pin.

The address map (figure 6) gives the addresses of data registers and data direction registers. Figure 21 provides some examples of port connections.

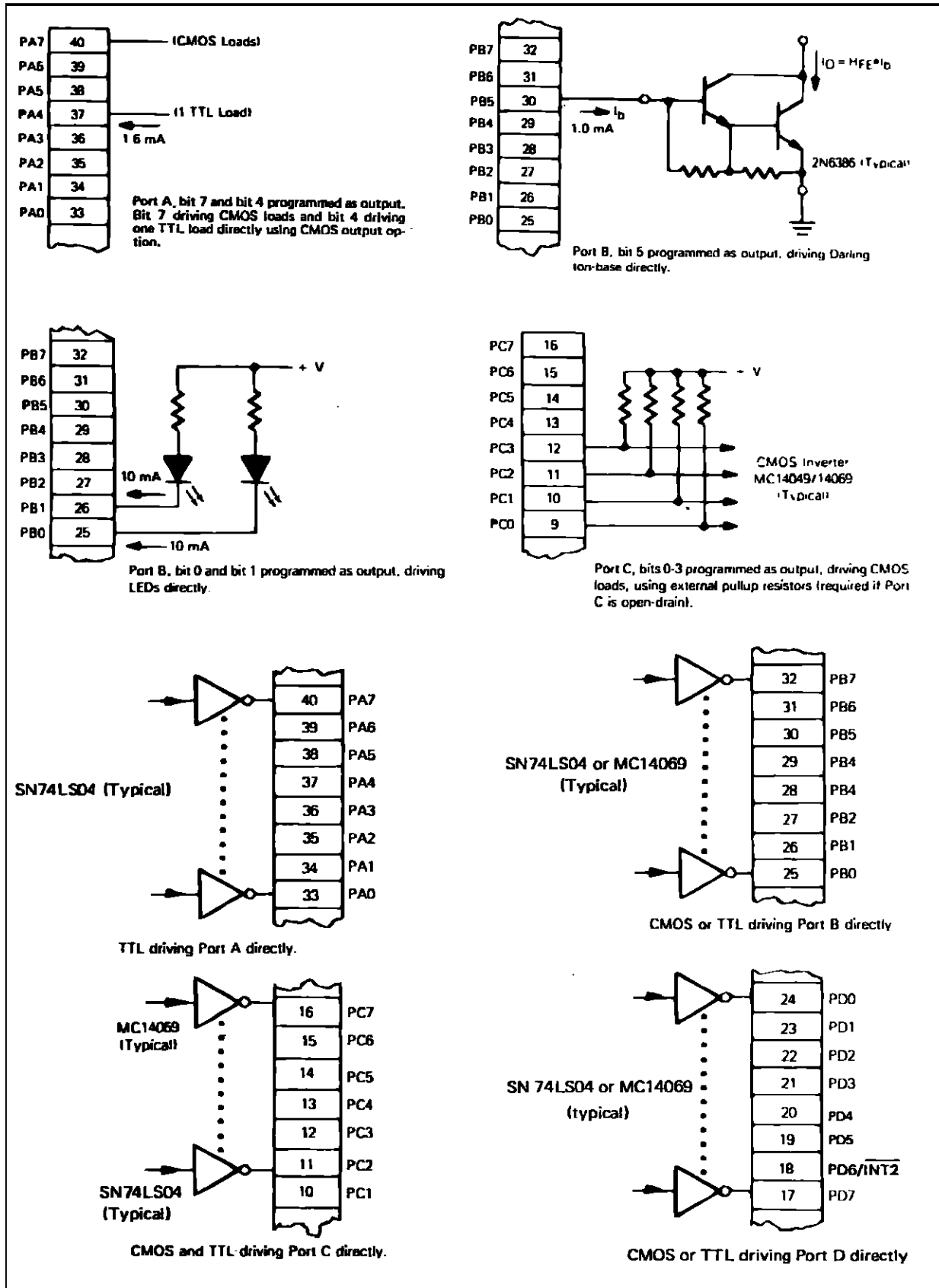
CAUTION

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, \$006).

A read operation on these registers is undefined. Since BSET and BCLR are read-modify-write in function, they cannot be used to set or clear a single DDR bit (all "unaffected" bits would be set). It is recommended that all DDR bits in a port be written using a single-store instruction.

The latched output data bit (see figure 20) must always be written. Therefore, any write to a port writes all of its data bits even though the port DDR is set to input. This may be used to initialize the data register and avoid undefined outputs ; however, care must be exercised when using read-modify-write instructions, since the data read corresponds to the pin level if the DDR is an input (zero) and corresponds to the latched output data when the DDR is an output (one).

Figure 21 : Typical Port Connections.



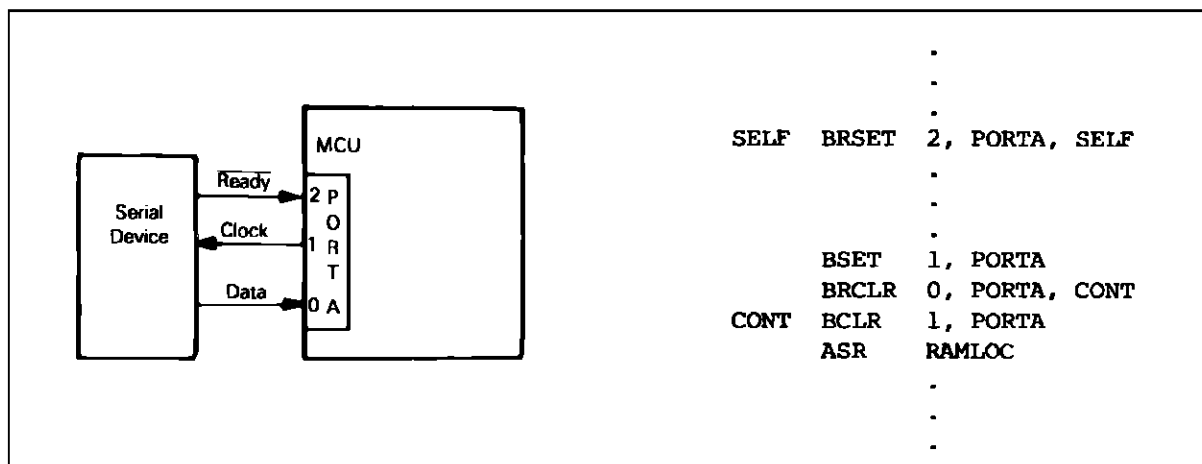
SOFTWARE

BIT MANIPULATION

The EF6805U3 MCU has the ability to set or clear any single random access memory or input/output bit (except the data direction register, see Caution below), with a single instruction (BSET, BCLR). Any bit in page zero including ROM, except the DDRs, can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state. The carry bit equals the value of the bit referenced by BRSET or BRCLR. A rotate instruction may then be used to accumulate serial input data in a RAM location or register. The capability to work with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle I/O bits as control lines.

The coding example in figure 21 illustrates the usefulness of the bit manipulation and test instructions.

Figure 21 : Bit Manipulation Example.



ADDRESSING MODES

The EF6805P2 MCU has 10 addressing modes which are explained briefly in the following paragraphs. For additional details and graphical illustrations, refer to the 6805 Family User's Manual.

The term "effective address" (EA) is used in describing the address modes. EA is defined as the address from which the argument for an instruction is fetched or stored.

IMMEDIATE - In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).

DIRECT - In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte. Direct addressing al-

Assume that the MCU is to communicate with an external serial device.

The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a time. LSB first, out of the device. The MCU waits until the data is ready, clocks the external device, picks up the data in the carry flag (C bit), clears the clock line, and finally accumulates the data bit in a RAM location.

Caution

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006). A read operation on these registers is undefined. Since BSET and BCLR are read-modify-write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would be set). It is recommended that all DDR bits in a port be written using a single-store instruction.

lows the user to directly address the lowest 256 bytes in memory with a single 2-byte instruction. This includes the on-chip RAM and I/O registers and 128 bytes of ROM. Direct addressing is an effective use of both memory and time.

EXTENDED - In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode. Instructions using extended addressing are capable of referencing arguments anywhere in memory with a single 3-byte instruction. When using the Motorola assembler, the programmer need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the shortest for of the instruction.

RELATIVE - The relative addressing mode is only used in branch instructions. In relative addressing, the contents of the 8-bit signed byte following the opcode (the offset) is added to the PC if and only if the

branch condition is true. Otherwise, control proceeds to the next instruction. The span of relative addressing is from - 126 to + 129 from the opcode address. The programmer need not worry about calculating the correct offset when using the Motorola assembler since it calculates the proper offset and checks to see if it is within the span of the branch.

INDEXED, NO OFFSET - In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location.

INDEXED, 8-BIT OFFSET - In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the unsigned byte following the opcode. This addressing mode is useful in selecting the kth element in an n element table. With this 2-byte instruction, k would typically be in X with the address of the beginning of the table in the instruction. As such, tables may begin anywhere within the first 256 addressable locations and could extend as far as location 510 (\$1FE is the last location at which the instruction may begin).

INDEXED, 16-BIT OFFSET - In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This addressing mode can be used in a manner similar to indexed, 8-bit offset, except that this 3-byte instruction allows tables to be anywhere in memory. As with direct and extended addressing, the Motorola assembler determines the shortest form of indexed addressing.

BIT SET/CLEAR - In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode, and the byte following the opcode specifies the direct address of the byte in which the specified bit is to be set or cleared. Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single 2-byte instruction.

Caution

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006). A read operation on these registers is undefined. Since BSET and BCLR are read-modify-write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would

be set). It is recommended that all DDR bits in a port be written using a single-store instruction.

BIT TEST AND BRANCH - The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit and condition (set or clear) which is to be tested is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8-bit offset is in the third byte and is added to the value of the PC if the branch condition is true. This single 3-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory. The span of branching is from - 125 to + 130 from the opcode address. The state of the tested bit is also transferred to the carry bit of the condition code register.

Caution

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006). A read operation on these registers is undefined. Since BSET and BCLR are read-modify-write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would be set). It is recommended that all DDR bits in a port be written using a single-store instruction.

INHERENT - In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, as well as control instruction with no other arguments, are included in this mode. These instructions are one byte long.

INSTRUCTION SET

The EF6805U3 MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. They can be divided into five different types : register/memory, read-modify-write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

REGISTER/MEMORY INSTRUCTIONS - Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operands. Refer to table 1.

READ-MODIFY-WRITE MODIFICATIONS - These instructions read a memory location or a register,

modify or test its contents, and write the modified value back to memory or to the register. The test for negative or zero (TST) instruction is included in read-modify-write instructions through it does not perform the write. Refer to table 2.

Caution

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006). A read operation on these registers is undefined. Since BSET and BCLR are read-modify-write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would be set). It is recommended that all DDR bits in a port be written using a single-store instruction.

BRANCH INSTRUCTIONS - The branch instructions cause a branch from the program when a certain condition is met. Refer to table 3.

BIT MANIPULATION INSTRUCTIONS - These instructions are used on any bit in the first 256 bytes of

the memory. One group either sets or clears. The other group performs the bit test branch operations. Refer to table 4.

Caution

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006). A read operation on these registers is undefined. Since BSET and BCLR are read-modify-write functions, they cannot be used to set or clear a DDR bit (all "unaffected" bits would be set). It is recommended that all DDR bits in a port be written using a single-store instruction.

CONTROL INSTRUCTIONS - The control instructions control the MCU operations during program execution. Refer to table 5.

ALPHABETICAL LISTING - The complete instruction set is given in alphabetical order in table 6.

OPCODE MAP SUMMARY - Table 7 is an opcode map for the instructions used on the MCU.

Table 1 : Register/Memory Instructions.

Function		Addressing Modes																	
		Immediate			Direct			Extended			Indexed (No Offset)			Indexed (8-Bit Offset)			Indexed (16-Bit Offset)		
		Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles
Load A from Memory	LDA	A6	2	2	B6	2	4	C6	3	5	F6	1	4	E6	2	5	D6	3	6
Load X from Memory	LDX	AE	2	2	BE	2	4	CE	3	5	FE	1	4	EE	2	5	DE	3	6
Store A in Memory	STA	-	-	-	B7	2	5	C7	3	6	F7	1	5	E7	2	6	D7	3	7
Store X in Memory	STX	-	-	-	BF	2	5	CF	3	6	FF	1	5	EF	2	6	DF	3	7
Add Memory to A	ADD	AB	2	2	BB	2	4	CB	3	5	FB	1	4	EB	2	5	DB	3	6
Add Memory and Carry to A	ADC	A9	2	2	B9	2	4	C9	3	5	F9	1	4	E9	2	5	D9	3	6
Subtract Memory	SUB	A0	2	2	B0	2	4	C0	3	5	F0	1	4	E0	2	5	D0	3	6
Subtract Memory from A with Borrow	SBC	A2	2	2	B2	2	4	C2	3	5	F2	1	4	E2	2	5	D2	3	6
AND Memory to A	AND	A4	2	2	B4	2	4	C4	3	5	F4	1	4	E4	2	5	D4	3	6
OR Memory with A	ORA	AA	2	2	BA	2	4	CA	3	5	FA	1	4	EA	2	5	DA	3	6
Exclusive OR Memory with A	EOR	AB	2	2	BB	2	4	CB	3	5	FB	1	4	EB	2	5	DB	3	6
Arithmetic Compare A with Memory	CMP	A1	2	2	B1	2	4	C1	3	5	F1	1	4	E1	2	5	D1	3	6
Arithmetic Compare X with Memory	CPX	A3	2	2	B3	2	4	C3	3	5	F3	1	4	E3	2	5	D3	3	6
Bit Test Memory with A (Logical Compare)	BIT	A5	2	2	B5	2	4	C5	3	5	F5	1	4	E5	2	5	D5	3	6
Jump Unconditional	JMP	-	-	-	BC	2	3	CC	3	4	FC	1	3	EC	2	4	DC	3	5
Jump to Subroutine	JSR	-	-	-	BD	2	7	CD	3	8	FD	1	7	ED	2	8	DD	3	9

Table 2 : Read-Modify-Write Instructions.

Addressing Modes																		
Function	Mnemonic	Inherent (A)				Inherent (X)				Direct			Indexed (No Offset)			Indexed (8 B+1 Offset)		
		Op Code	# Bytes	# Cycles	#	Op Code	# Bytes	# Cycles	#	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles
Increment	INC	4C	1	4	4	5C	1	4	4	3C	2	6	7C	1	6	6C	2	7
Decrement	DEC	4A	1	4	4	5A	1	4	4	3A	2	6	7A	1	6	6A	2	7
Clear	CLR	4F	1	4	4	5F	1	4	4	3F	2	6	7F	1	6	6F	2	7
Complement	COM	43	1	4	4	53	1	4	4	33	2	6	73	1	6	63	2	7
Negate (2's Complement)	NEG	40	1	4	4	50	1	4	4	30	2	6	70	1	6	60	2	7
Rotate Left Thru Carry	ROL	49	1	4	4	59	1	4	4	39	2	6	79	1	6	69	2	7
Rotate Right Thru Carry	ROR	46	1	4	4	56	1	4	4	36	2	6	76	1	6	66	2	7
Logical Shift Left	LSL	48	1	4	4	58	1	4	4	38	2	6	78	1	6	68	2	7
Logical Shift Right	LSR	44	1	4	4	54	1	4	4	34	2	6	74	1	6	64	2	7
Arithmetic Shift Right	ASR	47	1	4	4	57	1	4	4	37	2	6	77	1	6	67	2	7
Test for Negative or Zero	TST	4D	1	4	4	5D	1	4	4	3D	2	6	7D	1	6	6D	2	7

Table 3 : Branch Instructions.

Function	Mnemonic	Relative Addressing Mode		
		Op Code	# Bytes	# Cycles
Branch Always	BRA	20	2	4
Branch Never	BRN	21	2	4
Branch IFF Higher	BHI	22	2	4
Branch IFF Lower or Same	BLS	23	2	4
Branch IFF Carry Clear	BCC	24	2	4
(branch IFF higher or same)	(BHS)	24	2	4
Branch IFF Carry Set	BCS	25	2	4
(branch IFF lower)	(BLO)	25	2	4
Branch IFF Not Equal	BNE	26	2	4
Branch IFF Equal	BEQ	27	2	4
Branch IFF Half Carry Clear	BHCC	28	2	4
Branch IFF Half Carry Set	BHCS	29	2	4
Branch IFF Plus	BPL	2A	2	4
Branch IFF Minus	BMI	2B	2	4
Branch IFF interrupt mask bit is clear.	BMC	2C	2	4
Branch IFF interrupt mask bit is set.	BMS	2D	2	4
Branch IFF interrupt line is low.	BIL	2E	2	4
Branch IFF interrupt line is high.	BIH	2F	2	4
Branch to Subroutine	BSR	AD	2	8

Table 4 : Bit Manipulation Instructions.

Function	Mnemonic	Addressing Modes					
		Bit Set/clear			Bit Test and Branch		
		Op Code	# Bytes	# Cycles	Op Code	# Bytes	# Cycles
Branch IFF Bit n is set	BRSET n (n = 0... 7)				2 • n	3	10
Branch IFF Bit n is clear	BRCLR n (n = 0... 7)				01 + 2 • n	3	10
Set Bit n	BSET n (n = 0... 7)	10 + 2 • n	2	7			
Clear Bit n	BCLR n (n = 0... 7)	11 + 2 • n	2	7			

Table 5 : Control Instructions.

Function	Mnemonic	Inherent		
		Op Code	# Bytes	# Cycles
Transfer A to X	TAX	97	1	2
Transfer X to A	TXA	9F	1	2
Set Carry Bit	SEC	99	1	2
Clear Carry Bit	CLC	98	1	2
Set Interrupt Mask Bit	SEI	9B	1	2
Clear Interrupt Mask Bit	CLI	9A	1	2
Software Interrupt	SWI	83	1	11
Return from Subroutine	RTS	81	1	6
Return from Interrupt	RTI	80	1	9
Reset Stack Pointer	RSP	9C	1	2
No-operation	NOP	9D	1	2

Table 6 : Instruction Set.

Mnem	Addressing Modes										Condition Code				
	Inherent	Immediate	Direct	Extended	Relative	Indexed (no offset)	Indexed (8 Bits)	Indexed (16 Bits)	Bit Set/Clear	Bit Test & Branch	H	I	N	Z	C
ADC		X	X	X		X	X	X			^	●	^	^	^
ADD		X	X	X		X	X	X			^	●	^	^	^
AND		X	X	X		X	X	X			●	●	^	^	●
ASL	X		X			X	X				●	●	^	^	^
ASR	X		X			X	X				●	●	^	^	^
BCC					X						●	●	●	●	●
BCLR									X		●	●	●	●	●
BCS					X						●	●	●	●	●
BEQ					X						●	●	●	●	●
BHCC					X						●	●	●	●	●
BHCS					X						●	●	●	●	●
BHI					X						●	●	●	●	●
BHS					X						●	●	●	●	●
BIH					X						●	●	●	●	●
BIL					X						●	●	●	●	●
BIT		X	X	X		X	X	X			●	●	^	^	●
BLO					X						●	●	●	●	●
BLS					X						●	●	●	●	●
BMC					X						●	●	●	●	●
BMI					X						●	●	●	●	●
BMS					X						●	●	●	●	●
BNE					X						●	●	●	●	●
BPL					X						●	●	●	●	●
BRA					X						●	●	●	●	●
BRN					X						●	●	●	●	●
BRCLR										X	●	●	●	●	^
BRSET										X	●	●	●	●	^
BSET									X		●	●	●	●	●
BSR					X						●	●	●	●	●
CLL	X										●	●	●	●	0

Table 6 : Instruction Set (continued).

Mnem	Addressing Modes										Condition Code				
	Inherent	Immediate	Direct	Extended	Relative	Indexed (no offset)	Indexed (8 Bits)	Indexed (16 Bits)	Bit Set/clear	Bit Test & Branch	H	I	N	Z	C
CLI	X										●	0	●	●	●
CLR	X		X			X	X				●	●	0	1	●
CMP		X	X	X		X	X	X			●	●	^	^	^
COM	X		X			X	X				●	●	^	^	1
CPX		X	X	X		X	X	X			●	●	^	^	^
DEC	X		X			X	X				●	●	^	^	●
EOR		X	X	X		X	X	X			●	●	^	^	●
INC	X		X			X	X				●	●	^	^	●
JMP			X	X		X	X	X			●	●	●	●	●
JSR			X	X		X	X	X			●	●	●	●	●
LDA		X	X	X		X	X	X			●	●	^	^	●
LDX		X	X	X		X	X	X			●	●	^	^	●
LSL	X		X			X	X				●	●	^	^	^
LSR	X		X			X	X				●	●	0	^	^
NEQ	X		X			X	X				●	●	^	^	^
NOP	X										●	●	●	●	●
ORA		X	X	X		X	X	X			●	●	^	^	●
ROL	X		X			X	X				●	●	^	^	^
RSP	X										●	●	●	●	●
RTI	X										?	?	?	?	?
RTS	X										●	●	●	●	●
SBC		X	X	X		X	X	X			●	●	^	^	^
SEC	X										●	●	●	●	1
SEI	X										●	1	●	●	●
STA			X	X		X	X	X			●	●	^	^	●
STX			X	X		X	X	X			●	●	^	^	●
SUB		X	X	X		X	X	X			●	●	^	^	^
SWI	X										●	1	●	●	●
TAX	X										●	●	●	●	●
TST	X		X			X	X				●	●	^	^	●
TXA	X										●	●	●	●	●

Condition Code Symbols :

H
I Interrupt Mask
N

Z
C Half Carry (from bit 3)
^ Test and Set if True, Cleared Otherwise
● Not Affected (sign bit)

HMOS 6805 FAMILY

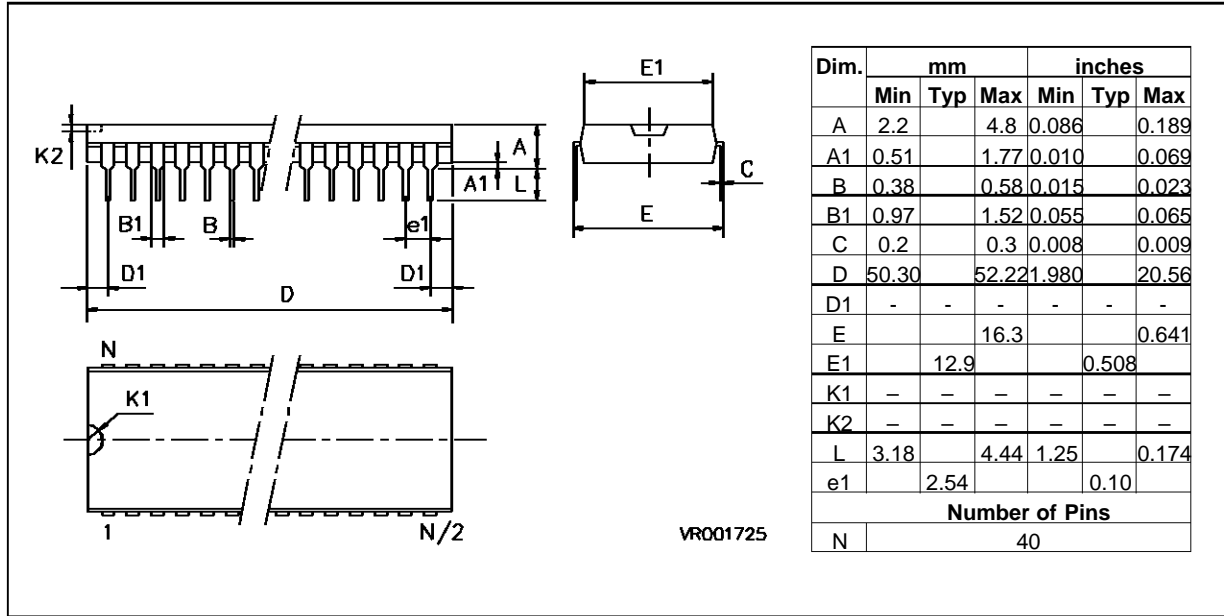
Features	EF6805P2	EF6805P6	EF6805R2	EF6805R3	EF6805U2	EF6805U3
Technology	HMOS	HMOS	HMOS	HMOS	HMOS	HMOS
Number of Pins	28	28	40	40	40	40
On-chip RAM (bytes)	64	64	64	112	64	112
On-chip User ROM (bytes)	1100	1796	2048	3776	2048	3776
External Bus	None	None	None	None	None	None
Bidirectional I/O Lines	20	20	24	24	24	24
Unidirectional I/O Lines	None	None	6 Inputs	6 Inputs	8 Inputs	8 Inputs
Other I/O Features	Timer	Timer	Timer, A/D	Timer, A/D	Timer	Timer
External Interrupt Inputs	1	1	2	2	2	2
STOP and WAIT	No	No	No	No	No	No

Table 7 : 6805 HMOS Family Opcode MAP.

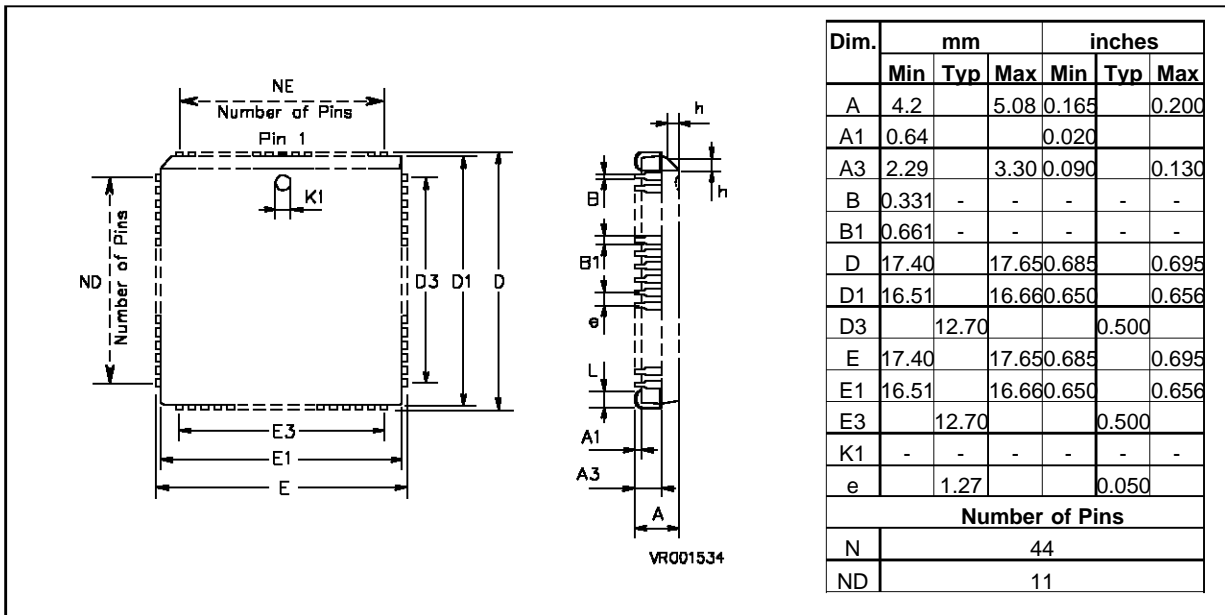
Low	High	Bit Manipulation	Branch	Read-Modify-Write	Control	Register/Memory	Low	High
0000	0001	BSET0	BRA	NEG	INH	SUB	0000	0001
0001	0002	BCLF0	BRN	NEG	INH	SUB	0002	0003
0002	0003	BSET1	BRA	NEG	INH	SUB	0004	0005
0003	0004	BCLF1	BRN	NEG	INH	SUB	0006	0007
0004	0005	BSET2	BRA	NEG	INH	SUB	0008	0009
0005	0006	BCLF2	BRN	NEG	INH	SUB	0010	0011
0006	0007	BSET3	BRA	NEG	INH	SUB	0012	0013
0007	0008	BCLF3	BRN	NEG	INH	SUB	0014	0015
0008	0009	BSET4	BRA	NEG	INH	SUB	0016	0017
0009	0010	BCLF4	BRN	NEG	INH	SUB	0018	0019
0010	0011	BSET5	BRA	NEG	INH	SUB	0020	0021
0011	0012	BCLF5	BRN	NEG	INH	SUB	0022	0023
0012	0013	BSET6	BRA	NEG	INH	SUB	0024	0025
0013	0014	BCLF6	BRN	NEG	INH	SUB	0026	0027
0014	0015	BSET7	BRA	NEG	INH	SUB	0028	0029
0015	0016	BCLF7	BRN	NEG	INH	SUB	0030	0031
0016	0017	BSET8	BRA	NEG	INH	SUB	0032	0033
0017	0018	BCLF8	BRN	NEG	INH	SUB	0034	0035
0018	0019	BSET9	BRA	NEG	INH	SUB	0036	0037
0019	0020	BCLF9	BRN	NEG	INH	SUB	0038	0039
0020	0021	BSET10	BRA	NEG	INH	SUB	0040	0041
0021	0022	BCLF10	BRN	NEG	INH	SUB	0042	0043
0022	0023	BSET11	BRA	NEG	INH	SUB	0044	0045
0023	0024	BCLF11	BRN	NEG	INH	SUB	0046	0047
0024	0025	BSET12	BRA	NEG	INH	SUB	0048	0049
0025	0026	BCLF12	BRN	NEG	INH	SUB	0050	0051
0026	0027	BSET13	BRA	NEG	INH	SUB	0052	0053
0027	0028	BCLF13	BRN	NEG	INH	SUB	0054	0055
0028	0029	BSET14	BRA	NEG	INH	SUB	0056	0057
0029	0030	BCLF14	BRN	NEG	INH	SUB	0058	0059
0030	0031	BSET15	BRA	NEG	INH	SUB	0060	0061
0031	0032	BCLF15	BRN	NEG	INH	SUB	0062	0063
0032	0033	BSET16	BRA	NEG	INH	SUB	0064	0065
0033	0034	BCLF16	BRN	NEG	INH	SUB	0066	0067
0034	0035	BSET17	BRA	NEG	INH	SUB	0068	0069
0035	0036	BCLF17	BRN	NEG	INH	SUB	0070	0071
0036	0037	BSET18	BRA	NEG	INH	SUB	0072	0073
0037	0038	BCLF18	BRN	NEG	INH	SUB	0074	0075
0038	0039	BSET19	BRA	NEG	INH	SUB	0076	0077
0039	0040	BCLF19	BRN	NEG	INH	SUB	0078	0079
0040	0041	BSET20	BRA	NEG	INH	SUB	0080	0081
0041	0042	BCLF20	BRN	NEG	INH	SUB	0082	0083
0042	0043	BSET21	BRA	NEG	INH	SUB	0084	0085
0043	0044	BCLF21	BRN	NEG	INH	SUB	0086	0087
0044	0045	BSET22	BRA	NEG	INH	SUB	0088	0089
0045	0046	BCLF22	BRN	NEG	INH	SUB	0090	0091
0046	0047	BSET23	BRA	NEG	INH	SUB	0092	0093
0047	0048	BCLF23	BRN	NEG	INH	SUB	0094	0095
0048	0049	BSET24	BRA	NEG	INH	SUB	0096	0097
0049	0050	BCLF24	BRN	NEG	INH	SUB	0098	0099
0050	0051	BSET25	BRA	NEG	INH	SUB	0100	0101
0051	0052	BCLF25	BRN	NEG	INH	SUB	0102	0103
0052	0053	BSET26	BRA	NEG	INH	SUB	0104	0105
0053	0054	BCLF26	BRN	NEG	INH	SUB	0106	0107
0054	0055	BSET27	BRA	NEG	INH	SUB	0108	0109
0055	0056	BCLF27	BRN	NEG	INH	SUB	0110	0111
0056	0057	BSET28	BRA	NEG	INH	SUB	0112	0113
0057	0058	BCLF28	BRN	NEG	INH	SUB	0114	0115
0058	0059	BSET29	BRA	NEG	INH	SUB	0116	0117
0059	0060	BCLF29	BRN	NEG	INH	SUB	0118	0119
0060	0061	BSET30	BRA	NEG	INH	SUB	0120	0121
0061	0062	BCLF30	BRN	NEG	INH	SUB	0122	0123
0062	0063	BSET31	BRA	NEG	INH	SUB	0124	0125
0063	0064	BCLF31	BRN	NEG	INH	SUB	0126	0127
0064	0065	BSET32	BRA	NEG	INH	SUB	0128	0129
0065	0066	BCLF32	BRN	NEG	INH	SUB	0130	0131
0066	0067	BSET33	BRA	NEG	INH	SUB	0132	0133
0067	0068	BCLF33	BRN	NEG	INH	SUB	0134	0135
0068	0069	BSET34	BRA	NEG	INH	SUB	0136	0137
0069	0070	BCLF34	BRN	NEG	INH	SUB	0138	0139
0070	0071	BSET35	BRA	NEG	INH	SUB	0140	0141
0071	0072	BCLF35	BRN	NEG	INH	SUB	0142	0143
0072	0073	BSET36	BRA	NEG	INH	SUB	0144	0145
0073	0074	BCLF36	BRN	NEG	INH	SUB	0146	0147
0074	0075	BSET37	BRA	NEG	INH	SUB	0148	0149
0075	0076	BCLF37	BRN	NEG	INH	SUB	0150	0151
0076	0077	BSET38	BRA	NEG	INH	SUB	0152	0153
0077	0078	BCLF38	BRN	NEG	INH	SUB	0154	0155
0078	0079	BSET39	BRA	NEG	INH	SUB	0156	0157
0079	0080	BCLF39	BRN	NEG	INH	SUB	0158	0159
0080	0081	BSET40	BRA	NEG	INH	SUB	0160	0161
0081	0082	BCLF40	BRN	NEG	INH	SUB	0162	0163
0082	0083	BSET41	BRA	NEG	INH	SUB	0164	0165
0083	0084	BCLF41	BRN	NEG	INH	SUB	0166	0167
0084	0085	BSET42	BRA	NEG	INH	SUB	0168	0169
0085	0086	BCLF42	BRN	NEG	INH	SUB	0170	0171
0086	0087	BSET43	BRA	NEG	INH	SUB	0172	0173
0087	0088	BCLF43	BRN	NEG	INH	SUB	0174	0175
0088	0089	BSET44	BRA	NEG	INH	SUB	0176	0177
0089	0090	BCLF44	BRN	NEG	INH	SUB	0178	0179
0090	0091	BSET45	BRA	NEG	INH	SUB	0180	0181
0091	0092	BCLF45	BRN	NEG	INH	SUB	0182	0183
0092	0093	BSET46	BRA	NEG	INH	SUB	0184	0185
0093	0094	BCLF46	BRN	NEG	INH	SUB	0186	0187
0094	0095	BSET47	BRA	NEG	INH	SUB	0188	0189
0095	0096	BCLF47	BRN	NEG	INH	SUB	0190	0191
0096	0097	BSET48	BRA	NEG	INH	SUB	0192	0193
0097	0098	BCLF48	BRN	NEG	INH	SUB	0194	0195
0098	0099	BSET49	BRA	NEG	INH	SUB	0196	0197
0099	0100	BCLF49	BRN	NEG	INH	SUB	0198	0199
0100	0101	BSET50	BRA	NEG	INH	SUB	0200	0201
0101	0102	BCLF50	BRN	NEG	INH	SUB	0202	0203
0102	0103	BSET51	BRA	NEG	INH	SUB	0204	0205
0103	0104	BCLF51	BRN	NEG	INH	SUB	0206	0207
0104	0105	BSET52	BRA	NEG	INH	SUB	0208	0209
0105	0106	BCLF52	BRN	NEG	INH	SUB	0210	0211
0106	0107	BSET53	BRA	NEG	INH	SUB	0212	0213
0107	0108	BCLF53	BRN	NEG	INH	SUB	0214	0215
0108	0109	BSET54	BRA	NEG	INH	SUB	0216	0217
0109	0110	BCLF54	BRN	NEG	INH	SUB	0218	0219
0110	0111	BSET55	BRA	NEG	INH	SUB	0220	0221
0111	0112	BCLF55	BRN	NEG	INH	SUB	0222	0223
0112	0113	BSET56	BRA	NEG	INH	SUB	0224	0225
0113	0114	BCLF56	BRN	NEG	INH	SUB	0226	0227
0114	0115	BSET57	BRA	NEG	INH	SUB	0228	0229
0115	0116	BCLF57	BRN	NEG	INH	SUB	0230	0231
0116	0117	BSET58	BRA	NEG	INH	SUB	0232	0233
0117	0118	BCLF58	BRN	NEG	INH	SUB	0234	0235
0118	0119	BSET59	BRA	NEG	INH	SUB	0236	0237
0119	0120	BCLF59	BRN	NEG	INH	SUB	0238	0239
0120	0121	BSET60	BRA	NEG	INH	SUB	0240	0241
0121	0122	BCLF60	BRN	NEG	INH	SUB	0242	0243
0122	0123	BSET61	BRA	NEG	INH	SUB	0244	0245
0123	0124	BCLF61	BRN	NEG	INH	SUB	0246	0247
0124	0125	BSET62	BRA	NEG	INH	SUB	0248	0249
0125	0126	BCLF62	BRN	NEG	INH	SUB	0250	0251
0126	0127	BSET63	BRA	NEG	INH	SUB	0252	0253
0127	0128	BCLF63	BRN	NEG	INH	SUB	0254	0255
0128	0129	BSET64	BRA	NEG	INH	SUB	0256	0257
0129	0130	BCLF64	BRN	NEG	INH	SUB	0258	0259
0130	0131	BSET65	BRA	NEG	INH	SUB	0260	0261
0131	0132	BCLF65	BRN	NEG	INH	SUB	0262	0263
0132	0133	BSET66	BRA	NEG	INH	SUB	0264	0265
0133	0134	BCLF66	BRN	NEG	INH	SUB	0266	0267
0134	0135	BSET67	BRA	NEG	INH	SUB	0268	0269
0135	0136	BCLF67	BRN	NEG	INH	SUB	0270	0271
0136	0137	BSET68	BRA	NEG	INH	SUB	0272	0273
0137	0138	BCLF68	BRN	NEG	INH	SUB	0274	0275
0138	0139	BSET69	BRA	NEG	INH	SUB	0276	0277
0139	0140	BCLF69	BRN	NEG	INH	SUB	0278	0279
0140	0141	BSET70	BRA	NEG	INH	SUB	0280	0281
0141	0142	BCLF70	BRN	NEG	INH	SUB	0282	0283
0142	0143	BSET71	BRA	NEG	INH	SUB	0284	0285
0143	0144	BCLF71						

PACKAGE MECHANICAL DATA

40 Pin Plastic Dual In Line Package (PDIP)



44 Pin Plastic Quad Package (PLCC)



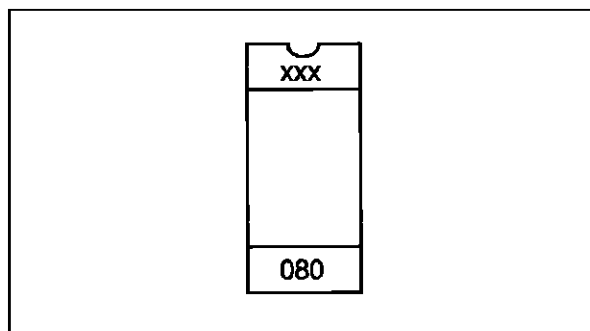
ORDERING INFORMATION

The information required when ordering a custom MCU is listed below. The ROM program may be transmitted to SGS-THOMSON on EPROM(s) or an EFDOS/MDOS* disk file.

To initiate a ROM pattern for the MCU, it is necessary to first contact your local SGS-THOMSON representative or distributor.

EPROMs

One 2716 or 2732 type EPROMs, programmed with the customer program (positive logic sense for ad-



XXX = Customer ID)

dress and data), may be submitted for pattern generation.

After the EPROM is marked, it should be placed in conductive IC carriers and securely packed. Do not use styrofoam.

VERIFICATION MEDIA

All original pattern media (EPROMs or floppy disk) are filed for contractual purposes and are not returned. A computer listing of the ROM code will be generated and returned along with a listing verification form. The listing should be thoroughly checked and the verification form completed, signed, and returned to SGS-THOMSON. The signed verification form constitutes the contractual agreement for creation of the customer mask. If desired, SGS-THOM-

SON will program on blank EPROM from the data file used to create the custom mask and aid in the verification process.

ROM VERIFICATION UNITS (RVUs)

Ten MCUs containing the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only. For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts. These RVUs are included in the mask change and are not production parts. The RVUs are thus not guaranteed by SGS THOMSON. Quality Assurance, and should be discarded after verification is completed.

FLEXIBLE DISKS

The disk media submitted must be single-sided, EFDOS/MDOS* compatible floppies.

The customer must write the binary file name and company name on the disk with a felt-tip-pen. The minimum EFDOS/MDOS* system files, as well as the absolute binary object file (Filename .LO type of file) from the 6805 cross assembler, must be on the disk. An object file made from a memory dump using the ROLLOUT command is also acceptable. Consider submitting a source listing as well as the following files: filename .LX (DEVICE/EXORciser loadable format) and filename .SA (ASCII Source Code). These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factory interface if the user finds any software errors and needs assistance quickly from SGS-THOMSON factory representatives.

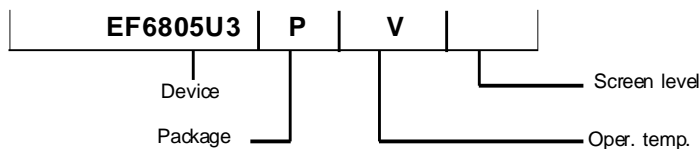
EFDOS is SGS-THOMSON Disk Operating System available on development systems such as DEVICE...

MDOS* is MOTOROLA's Disk Operating System available on development systems such as EXORciser...

* Requires prior factory approval.

Whenever ordering a custom MCU is required, please contact your local SGS-THOMSON representative or SGS-THOMSON distributor and/or complete and send the attached "MCU customer ordering sheet" to your local SGS-THOMSON Microelectronics representative.

ORDER CODES



The table below horizontally shows all available suffix combinations for package, operating temperature and screening level. Other possibilities on request.

Device	Package					Oper. Temp.			Screening Level			
	C	J	P	E	FN	L*	V	T	Std	D	G/B	B/B
EF6805U3			X		X	X	X	X	X	X		

Examples : EF6805U3P, EF6805U3FN, EF6805U3PV, EF6805U3FNV

Package : C : Ceramic DIL, J : Cerdip DIL, P : Plastic DIL, E : LCCC, FN : PLCC
Oper. temp. : L* : 0°C to + 70°C, V : - 40 °C to + 85°C, T : - 40°C to + 105°C, * : may be omitted.
Screening level : Std : (no-end suffix), D : NFC 96883 level D,
 EXORciser is a registered trademark of MOTOROLA Inc.

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